

High Accuracy, Hall-Effect-Based, 200 kHz Bandwidth, Galvanically Isolated Current Sensor IC with 100 $\mu\Omega$ Current Conductor

FEATURES AND BENEFITS

- AEC-Q100 Grade 1 qualified
- Typical of 2.5 μs output response time
- 5 V supply operation
- Ultra-low power loss: 100 $\mu\Omega$ internal conductor resistance
- Reinforced galvanic isolation allows use in economical, high-side current sensing in high-voltage systems
- 4800 Vrms dielectric strength certified under UL60950-1
- Industry-leading noise performance with greatly improved bandwidth through proprietary amplifier and filter design techniques
- Integrated shield greatly reduces capacitive coupling from current conductor to die due to high dV/dt signals, and prevents offset drift in high-side, high-voltage applications
- Greatly improved total output error through digitally programmed and compensated gain and offset over the full operating temperature range
- Small package size, with easy mounting capability
- Monolithic Hall IC for high reliability
- Output voltage proportional to AC or DC currents
- Factory-trimmed for accuracy
- Extremely stable output offset voltage

DESCRIPTION

The Allegro™ ACS772 family of current sensor ICs provide economical and precise solutions for AC or DC current sensing, ideal for motor control, load detection and management, power supply and DC-to-DC converter control, and inverter control. The 2.5 μs response time enables overcurrent fault detection in safety-critical applications.

The device consists of a precision, low-offset linear Hall circuit with a copper conduction path located near the die. Applied current flowing through this copper conduction path generates a magnetic field which the Hall IC converts into a proportional voltage. Device accuracy is optimized through the close proximity of the magnetic signal to the Hall transducer. A precise, proportional output voltage is provided by the low-offset, chopper-stabilized BiCMOS Hall IC, which is programmed for accuracy at the factory. Proprietary digital temperature compensation technology greatly improves the IC accuracy and temperature stability.

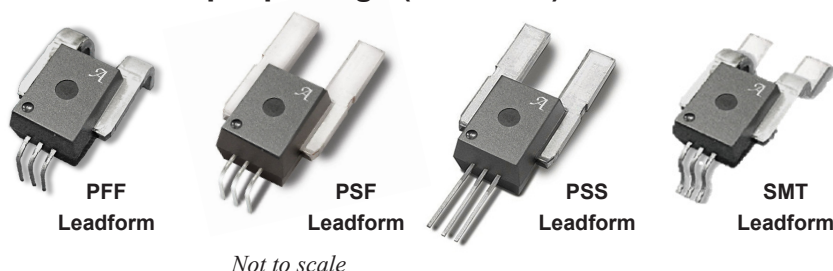
High-level immunity to current conductor dV/dt and stray electric fields is offered by Allegro proprietary integrated shield technology for low output voltage ripple and low offset drift in high-side, high-voltage applications.



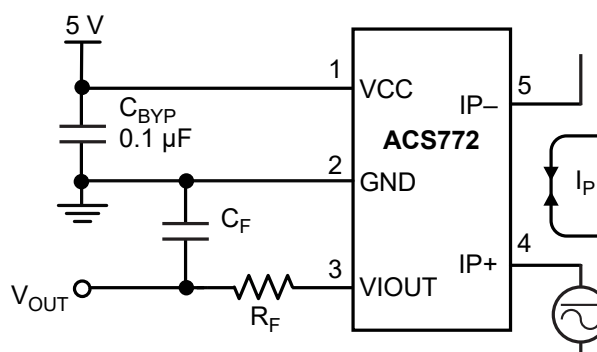
CB Certificate Number:
US-29755-UL

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PACKAGE: 5-pin package (suffix CB)



Application 1: the ACS772 outputs an analog signal, V_{OUT} , that varies linearly with the bidirectional AC or DC primary sensed current, I_P , within the range specified. R_F and C_F are for optimal noise management, with values that depend on the application.



Typical Application

DESCRIPTION (continued)

The output of the device increases when an increasing current flows through the primary copper conduction path (from terminal 4 to terminal 5), which is the path used for current sampling. The internal resistance of this conductive path is 100 $\mu\Omega$ typical, providing low power loss.

The thickness of the copper conductor allows survival of the device at high overcurrent conditions. The terminals of the conductive path are electrically isolated from the signal leads (pins 1 through 3). This

allows the ACS772 family of sensor ICs to be used in applications requiring electrical isolation without the use of opto-isolators or other costly isolation techniques.

The device is fully calibrated prior to shipment from the factory. The ACS772 family is lead (Pb) free. All leads are plated with 100% matte tin, and there is no Pb inside the package. The heavy gauge leadframe is made of oxygen-free copper.

ACS772

High Accuracy, Hall-Effect-Based, 200 kHz Bandwidth, Galvanically Isolated Current Sensor IC with 100 $\mu\Omega$ Current Conductor

SELECTION GUIDE

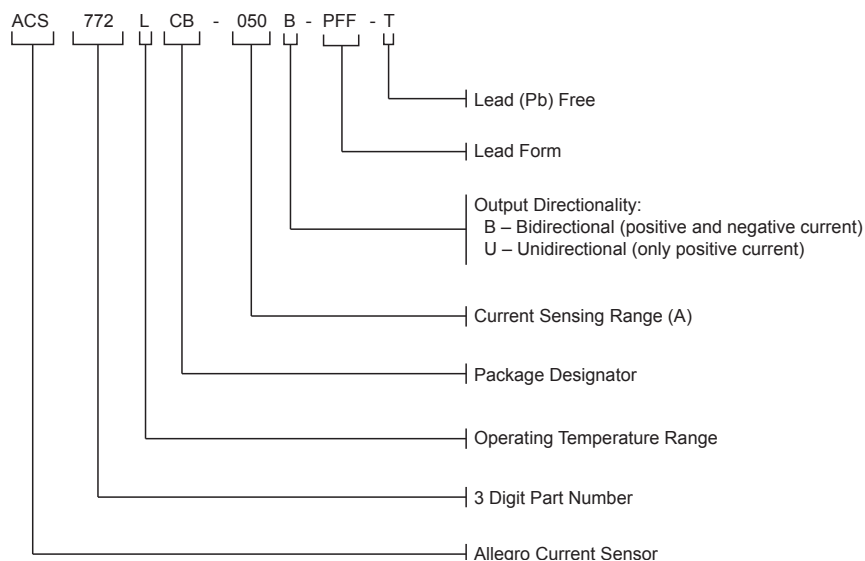
Part Number [1]	Package		Primary Sampled Current , I _P (A)	Sensitivity Sens (Typ.) (mV/A) [2]	Nominal T _A [3] (°C)	Packing [4]
	Terminals	Signal Pins				
ACS772LCB-050U-PFF-T	Formed	Formed	50	80	-40 to 150	34 pieces per tube
ACS772LCB-050B-PFF-T	Formed	Formed	±50	40		
ACS772LCB-050B-PSS-T	Straight	Straight				
ACS772LCB-050B-SMT-T	Formed	Formed				
ACS772LCB-100U-PFF-T	Formed	Formed	100	40		
ACS772LCB-100B-PFF-T	Formed	Formed	±100	20		
ACS772LCB-100B-SMT-T	Formed	Formed				
ACS772KCB-150U-PFF-T	Formed	Formed	150	26.66	-40 to 125	
ACS772KCB-150U-SMT-T	Formed	Formed				
ACS772KCB-150B-PFF-T	Formed	Formed	±150	13.33		
ACS772KCB-150B-SMT-T	Formed	Formed				
ACS772ECB-200U-PFF-T	Formed	Formed	200	20	-40 to 85	
ACS772ECB-200B-PFF-T	Formed	Formed	±200	10		
ACS772ECB-250U-PFF-T	Formed	Formed	250	16		
ACS772ECB-250U-PSF-T	Straight	Formed				
ACS772ECB-250B-PFF-T	Formed	Formed	±250	8		
ACS772ECB-250B-PSF-T	Straight	Formed				
ACS772ECB-300B-PFF-T	Formed	Formed	±300	6.66		
ACS772ECB-400U-PSF-T	Straight	Formed	400	10		
ACS772ECB-400B-PFF-T	Formed	Formed	±400	5		

[1] Additional leadform and sensitivity options available for qualified volumes.

[2] Measured at $V_{CC} = 5$ V.

[3] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[4] Contact Allegro for additional packing options.



ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Notes	Rating	Unit
Supply Voltage	V_{CC}		6.5	V
Reverse Supply Voltage	V_{RCC}		-0.5	V
Output Voltage	V_{IOUT}		6.5	V
Reverse Output Voltage	V_{RIOUT}		-0.5	V
Output Source Current	$I_{OUT(SOURCE)}$	V_{IOUT} to GND	3	mA
Output Sink Current	$I_{OUT(SINK)}$	Minimum pull-up resistor of 500 Ω from V_{CC} to V_{IOUT}	10	mA
Maximum Continuous Current	$I_{C(MAX)}$	$T_A = 25^\circ\text{C}$	250	A
Operating Ambient Temperature [1]	T_A	Range E, K, and L	-40 to 150	$^\circ\text{C}$
Maximum Junction Temperature	$T_{J(MAX)}$		165	$^\circ\text{C}$
Storage Temperature	T_{stg}		-65 to 165	$^\circ\text{C}$

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(MAX)}$, is not exceeded. See Thermal Application section of this datasheet for more information.

ESD RATINGS

Characteristic	Symbol	Test Conditions	Value	Unit
Human Body Model	V_{HBM}	Per JEDEC JS-001	± 6	kV
Charged Device Model	V_{CDM}	Per JEDEC JS-002	± 1	kV

ISOLATION CHARACTERISTICS

Characteristic	Symbol	Notes	Rating	Unit
Dielectric Surge Strength Test Voltage	V_{SURGE}	Tested ± 5 pulses at 2/minute in compliance to IEC 61000-4-5 1.2 μs (rise) / 50 μs (width)	8000	V
Dielectric Strength Test Voltage [2]	V_{ISO}	Agency type-tested for 60 seconds per UL standard 60950-1, 2nd Edition. Tested at 3000 V_{RMS} for 1 second in production.	4800	V_{RMS}
Working Voltage for Basic Isolation	V_{WVBI}	For basic (single) isolation per UL standard 60950-1, 2nd Edition	1358	V_{PK} or V_{DC}
			960	V_{RMS}
Working Voltage for Reinforced Isolation	V_{WFRI}	For reinforced (double) isolation per UL standard 60950-1, 2nd Edition	672	V_{PK} or V_{DC}
			475	V_{RMS}
Distance Through Insulation	DIT	Minimum internal distance through insulation	0.47	mm
Comparative Tracking Index	CTI	Material Group II	400 to 599	V

[2] Allegro does not conduct 60-second testing. It is done only during the UL certification process.

TYPICAL OVERCURRENT CAPABILITIES [4][5]

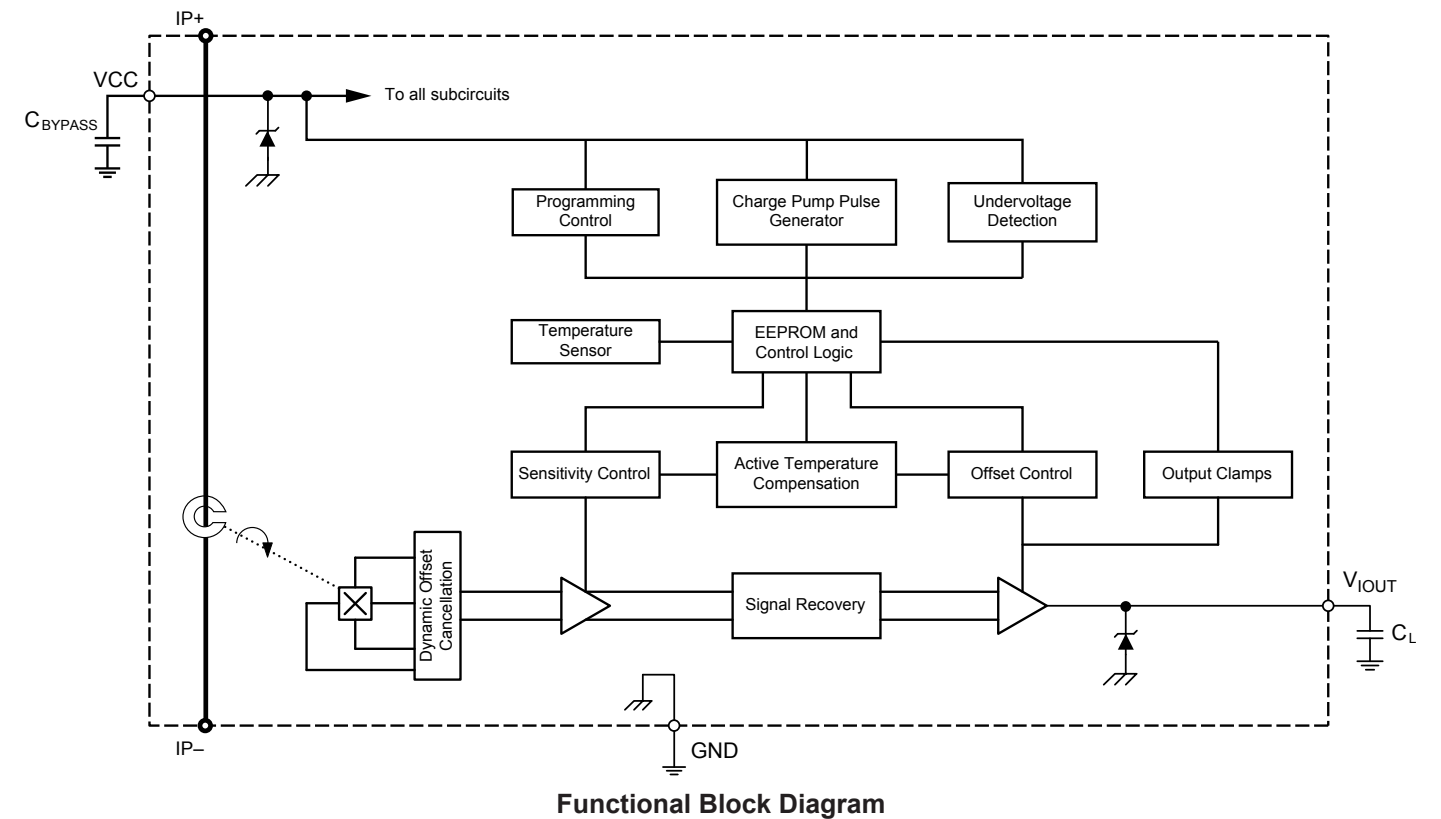
Characteristic	Symbol	Notes	Rating	Unit
Overcurrent	I_{POC}	$T_A = 25^\circ\text{C}$; current is on for 1 second and off for 99 seconds, 100 pulses applied	1200	A
		$T_A = 85^\circ\text{C}$; current is on for 1 second and off for 99 seconds, 100 pulses applied	900	A
		$T_A = 150^\circ\text{C}$; current is on for 1 second and off for 99 seconds, 100 pulses applied	600	A

[4] Test was done with Allegro evaluation board. The maximum allowed current is limited by $T_{J(MAX)}$ only.

[5] For more overcurrent profiles, please see FAQ on the Allegro website, www.allegromicro.com.

ACS772

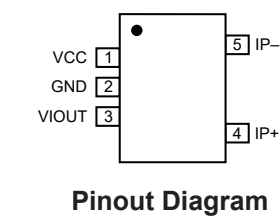
High Accuracy, Hall-Effect-Based, 200 kHz Bandwidth,
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THERMAL CHARACTERISTICS: May require derating at maximum conditions

Characteristic	Symbol	Test Conditions [3]	Value	Unit
Package Thermal Resistance	$R_{\theta JA}$	Mounted on the Allegro evaluation board with 2800 mm ² (1400 mm ² on component side and 1400 mm ² on opposite side) of 4 oz. copper connected to the primary leadframe and with thermal vias connecting the copper layers. Performance is based on current flowing through the primary leadframe and includes the power consumed by the PCB.	7	°C/W

[3] Additional thermal information available on the Allegro website.



Terminal List Table		
Number	Name	Description
1	VCC	Device power supply terminal
2	GND	Signal ground terminal
3	V_IOUT	Analog output signal
4	IP+	Terminal for current being sampled
5	IP-	Terminal for current being sampled

COMMON OPERATING CHARACTERISTICS: Valid at $T_A = -40^\circ\text{C}$ to 150°C , $C_{BYP} = 0.1\ \mu\text{F}$, and $V_{CC} = 5\ \text{V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
ELECTRICAL CHARACTERISTICS						
Supply Voltage	V_{CC}		4.5	5	5.5	V
Supply Current	I_{CC}	$V_{CC} = 5\ \text{V}$, no load on output	–	10	15	mA
Power-On Delay	t_{POD}	$T_A = 25^\circ\text{C}$	–	64	–	μs
Undervoltage Lockout (UVLO) Threshold ^[1]	V_{UVLOH}	V_{CC} rising at 1 V/ms and device functions enabled	–	4	–	V
	V_{UVLOL}	V_{CC} falling at 1 V/ms and device functions enabled	–	3.5	–	V
UVLO Hysteresis	$V_{HYS(UVLO)}$		250	–	–	mV
UVLO Enable/Disable Delay Time ^[1]	t_{UVLOE}	Time measured from falling $V_{CC} < V_{UVLOH}$ to UVLO enabled	–	64	–	μs
	t_{UVLOD}	Time measured from rising $V_{CC} > V_{UVLOH}$ to UVLO disabled	–	7	–	μs
Power-On Reset Voltage	V_{PORH}	V_{CC} rising at 1 V/ms	–	2.9	–	V
	V_{PORL}	V_{CC} falling at 1 V/ms	–	2.5	–	V
POR Hysteresis	$V_{HYS(POR)}$		250	–	–	mV
Rise Time	t_r	$T_A = 25^\circ\text{C}$, $C_L = 0.47\ \text{nF}$	–	2.4	–	μs
Propagation Delay Time	t_{PROP}	$T_A = 25^\circ\text{C}$, $C_L = 0.47\ \text{nF}$	–	1.2	–	μs
Response Time	$t_{RESPONSE}$	$T_A = 25^\circ\text{C}$, $C_L = 0.47\ \text{nF}$	–	2.5	–	μs
Output Slew Rate	SR	$T_A = 25^\circ\text{C}$, $C_L = 0.47\ \text{nF}$	–	0.67	–	V/ μs
Internal Bandwidth	BW_i	Small signal –3 dB, $C_L = 0.47\ \text{nF}$	–	200	–	kHz
DC Output Impedance	R_{OUT}	$T_A = 25^\circ\text{C}$	–	3.3	–	Ω
Output Load Resistance	$R_{LOAD(MIN)}$	VIOU to GND, VIOU to VCC	4.7	–	–	k Ω
Output Load Capacitance	$C_{LOAD(MAX)}$	VIOU to GND	–	1	10	nF
Primary Conductor Resistance	$R_{PRIMARY}$	$T_A = 25^\circ\text{C}$	–	100	–	$\mu\Omega$
Output Saturation Voltage	$V_{SAT(HIGH)}$	$T_A = 25^\circ\text{C}$, $R_{L(PULLDOWN)} = 10\ \text{k}\Omega$ to GND	$V_{CC} - 0.2$	–	–	V
	$V_{SAT(LOW)}$	$T_A = 25^\circ\text{C}$, $R_{L(PULLUP)} = 10\ \text{k}\Omega$ to VCC	–	–	200	mV
ERROR COMPONENTS						
QVO Ratiometry Error ^[2]	Rat_{ERRQVO}	$V_{CC} = 4.75$ to $5.25\ \text{V}$	–	± 0.15	–	%
Sens Ratiometry Error ^[2]	$\text{Rat}_{ERRSens}$	$V_{CC} = 4.75$ to $5.25\ \text{V}$	–	± 0.3	–	%
Noise	I_N	Input referenced noise density; $T_A = 25^\circ\text{C}$, $C_L = 1\ \text{nF}$	–	0.15	–	$\text{mA}/\sqrt{\text{Hz}}$
		Input referenced noise at 200 kHz; $T_A = 25^\circ\text{C}$, $C_L = 1\ \text{nF}$	–	85	–	mA_{RMS}
Nonlinearity ^[2]	E_{LIN}	Up to full scale of I_P	–0.9	± 0.5	0.9	%
Symmetry ^[2]	E_{SYM}	Over half-scale I_P	–0.8	± 0.4	0.8	%

^[1] UVLO feature is only available on part numbers programmed to work at $V_{CC} = 5\ \text{V}$.^[2] See Characteristic Definitions section of this datasheet.

X050U PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		0	–	50	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$80 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Unidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 10$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	20.4	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	3.4	–	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	–1	± 0.7	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.25	± 0.8	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	–8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	–8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	–20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	120	250	mA
Total Output Error	$E_{TOT(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X050B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-50	-	50	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	-	$40 \times V_{CC} / 5$	-	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	-	$V_{CC} / 2$	-	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	20.4	-	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	3.4	-	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	-1	± 0.7	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.8	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	-	210	250	mA
Total Output Error	$E_{\text{TOT}(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.9	1.5	%
	$E_{\text{TOT}(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{\text{TOT}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{\text{TOT}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{\text{OFF}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{\text{OFF}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X100U PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		0	–	100	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$40 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Unidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 10$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	20.4	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	3.4	–	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	–1	± 0.7	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.25	± 0.8	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	–8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	–8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	–20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	280	400	mA
Total Output Error	$E_{TOT(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X100B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-100	-	100	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	-	$20 \times V_{CC} / 5$	-	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	-	$V_{CC} / 2$	-	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	20.4	-	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	3.4	-	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	-1	± 0.7	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.8	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	-	175	400	mA
Total Output Error	$E_{TOT(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X150U PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		0	–	150	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$26.66 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Unidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 10$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	20.4	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	3.4	–	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	–1	± 0.7	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.25	± 0.8	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	–8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	–8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	–20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	280	400	mA
Total Output Error	$E_{\text{TOT}(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.5	± 0.9	1.5	%
	$E_{\text{TOT}(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{\text{TOT}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.7	2.1	%
	$E_{\text{TOT}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{\text{OFF}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–10	± 7	10	mV
	$E_{\text{OFF}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X150B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-150	-	150	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	-	$13.33 \times V_{CC} / 5$	-	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	-	$V_{CC} / 2$	-	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	7.2	-	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	1.2	-	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	-1	± 0.7	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.8	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	-	280	400	mA
Total Output Error	$E_{\text{TOT}(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.9	1.5	%
	$E_{\text{TOT}(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{\text{TOT}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{\text{TOT}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{\text{OFF}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{\text{OFF}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X200U PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		0	–	200	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$20 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Unidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 10$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	7.2	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	1.2	–	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	–1	± 0.5	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.25	± 0.7	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.5	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	–8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	–8	± 6	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	–20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	160	400	mA
Total Output Error	$E_{TOT(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	–1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens(LIFE)(HT)}}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.6	2.1	%
	$E_{\text{Sens(LIFE)(LT)}}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X200B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-200	-	200	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	-	$10 \times V_{CC} / 5$	-	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	-	$V_{CC} / 2$	-	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	5.1	-	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	0.85	-	mV _{RMS}
Sensitivity Error	E_{Sens}	Full scale of I_P , $T_A = 25^\circ\text{C}$	-1	± 0.5	1	%
		Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.7	1.25	%
		Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.5	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	-	380	400	mA
Total Output Error	$E_{TOT(HT)}$	Full scale of I_P , $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.7	1.5	%
	$E_{TOT(LT)}$	Full scale of I_P , $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.5	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X250U PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		0	–	250	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$16 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Unidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 10$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	5.1	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	0.85	–	mV _{RMS}
Sensitivity Error	E_{Sens}	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$	–1	± 0.7	1	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	–1.25	± 0.8	1.25	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	–8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	–8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	–20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	200	400	mA
Total Output Error	$E_{TOT(HT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	–1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X250B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-250	–	250	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$\frac{8 \times V_{CC}}{5}$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	–	$V_{CC}/2$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	5.1	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	0.85	–	mV _{RMS}
Sensitivity Error	E_{Sens}	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$	-1	± 0.7	1	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.8	1.25	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	175	400	mA
Total Output Error	$E_{TOT(HT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X300B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-300	-	300	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	-	$6.66 \times V_{CC} / 5$	-	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	-	$V_{CC} / 2$	-	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	5.1	-	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	-	0.85	-	mV _{RMS}
Sensitivity Error	E_{Sens}	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$	-1	± 0.7	1	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.8	1.25	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	-	175	400	mA
Total Output Error	$E_{TOT(HT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X400U PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		0	–	400	A
Sensitivity	Sens	$I_{PR(\min)} < I_P < I_{PR(\max)}$	–	$10 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Unidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 10$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	5.1	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	0.85	–	mV _{RMS}
Sensitivity Error	E_{Sens}	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$	–1	± 0.5	1	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	–1.25	± 0.7	1.25	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 1.5	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	–8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	–8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	–20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(\max)}$	–	245	400	mA
Total Output Error	$E_{\text{TOT}(HT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	–1.5	± 0.8	1.5	%
	$E_{\text{TOT}(LT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{\text{Sens}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.6	2.1	%
	$E_{\text{Sens}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{\text{TOT}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–2.1	± 1.7	2.1	%
	$E_{\text{TOT}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{\text{OFF}(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	–10	± 7	10	mV
	$E_{\text{OFF}(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	–20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(\text{MAX})}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

[2] Typical values are ± 3 sigma values. Typical values may be reevaluated once the specific part number is released to production.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

X400B PERFORMANCE CHARACTERISTICS: $T_A = -40^\circ\text{C}$ to 150°C [1], $V_{CC} = 5\text{ V}$, unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [2]	Max.	Unit
NOMINAL PERFORMANCE						
Current Sensing Range	I_{PR}		-400	–	400	A
Sensitivity	Sens	$I_{PR(min)} < I_P < I_{PR(max)}$	–	$5 \times V_{CC} / 5$	–	mV/A
Zero Current Output Voltage	$V_{IOUT(Q)}$	Bidirectional; $I_P = 0\text{ A}$	–	$V_{CC} / 2$	–	V
ACCURACY PERFORMANCE						
Noise	V_N	$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	5.1	–	mV _{p-p}
		$T_A = 25^\circ\text{C}$, $C_L = 1\text{ nF}$	–	0.85	–	mV _{RMS}
Sensitivity Error	E_{Sens}	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$	-1	± 0.7	1	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	-1.25	± 0.8	1.25	%
		$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
Electrical Offset Error	$V_{OE(TA)}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$	-8	± 4	8	mV
	$V_{OE(TA)HT}$	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$ to 150°C	-8	± 4	8	mV
	$V_{OE(TA)LT}$	$I_P = 0\text{ A}$, $T_A = -40^\circ\text{C}$ to 25°C	-20	± 6	20	mV
Magnetic Offset Error	I_{ERROM}	$I_P = 0\text{ A}$, $T_A = 25^\circ\text{C}$, after excursion of $I_{PR(max)}$	–	175	400	mA
Total Output Error	$E_{TOT(HT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = 25^\circ\text{C}$ to 150°C	-1.5	± 0.9	1.5	%
	$E_{TOT(LT)}$	$I_P = 200\text{ A}$, not tested at full scale I_P ; $T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 1.7	3.5	%
LIFETIME ACCURACY CHARACTERISTICS [3]						
Sensitivity Error Including Lifetime	$E_{Sens(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.6	2.1	%
	$E_{Sens(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.5	3.5	%
Total Output Error Including Lifetime	$E_{TOT(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-2.1	± 1.7	2.1	%
	$E_{TOT(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-3.5	± 2.6	3.5	%
Electric Offset Error Including Lifetime	$E_{OFF(LIFE)(HT)}$	$T_A = 25^\circ\text{C}$ to 150°C	-10	± 7	10	mV
	$E_{OFF(LIFE)(LT)}$	$T_A = -40^\circ\text{C}$ to 25°C	-20	± 8.9	20	mV

[1] All ACS772 devices are production tested and guaranteed to $T_A = 150^\circ\text{C}$, provided the Maximum Junction Temperature, $T_{J(MAX)}$, is not exceeded. See Absolute Maximum Ratings and Thermal Application section of this datasheet for more information.

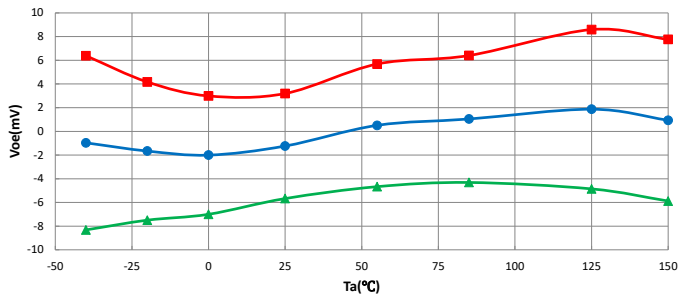
[2] Typical values are ± 3 sigma values.

[3] Min/max limits are derived from AEC-Q100 Grade 1 testing.

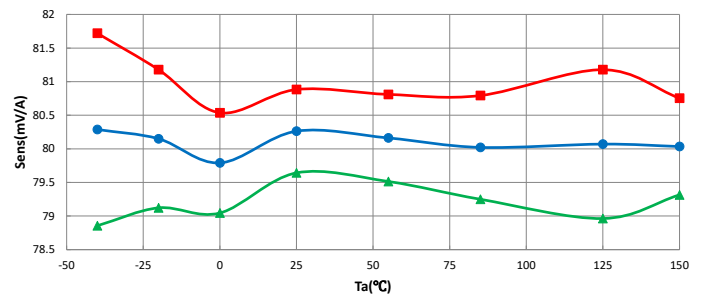
CHARACTERISTIC PERFORMANCE DATA

ACS772LCB-050U-PFF-T

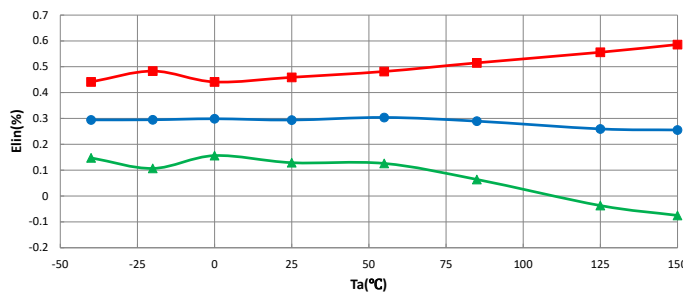
Electrical Offset Voltage versus Ambient Temperature



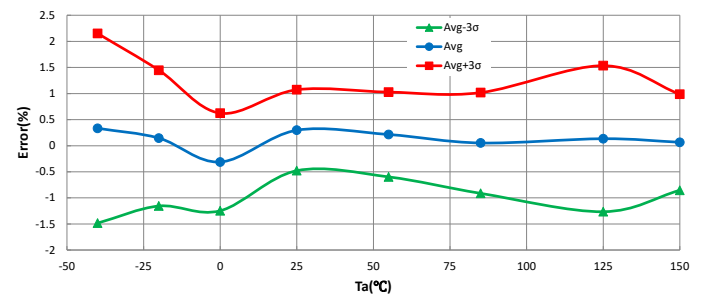
Sensitivity versus Ambient Temperature



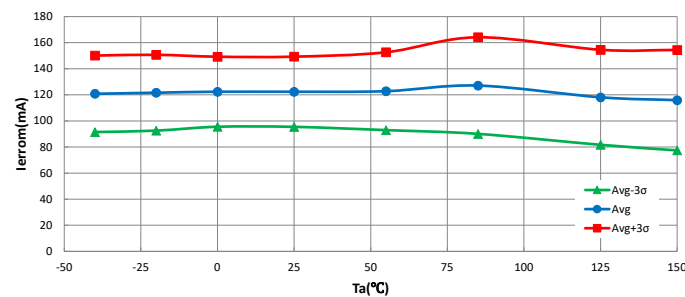
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

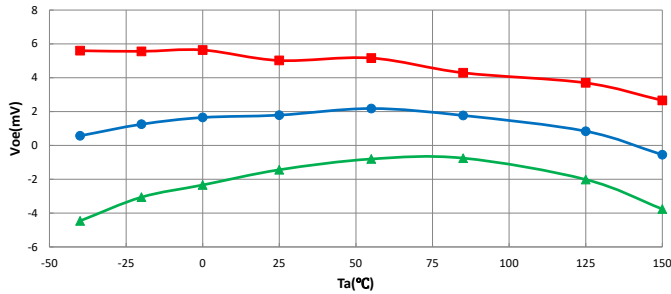


—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

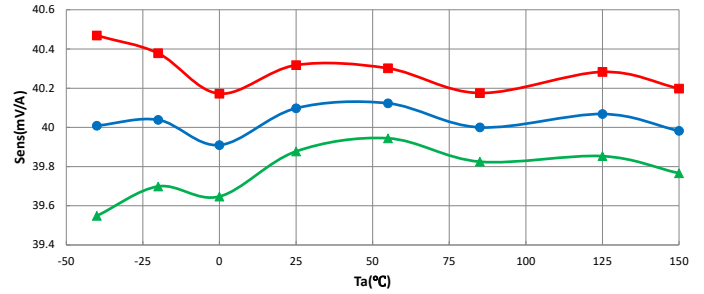
CHARACTERISTIC PERFORMANCE DATA

ACS772LCB-050B-PFF-T

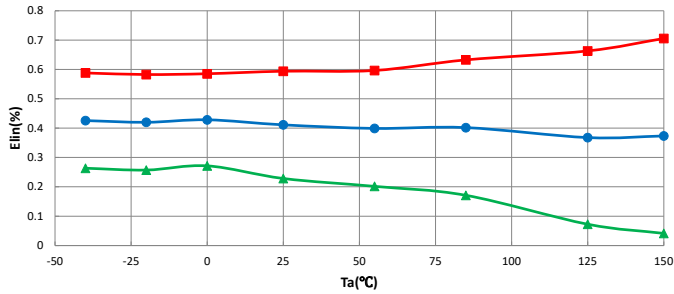
Electrical Offset Voltage versus Ambient Temperature



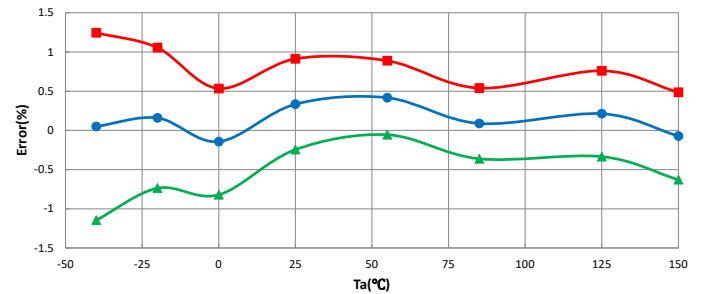
Sensitivity versus Ambient Temperature



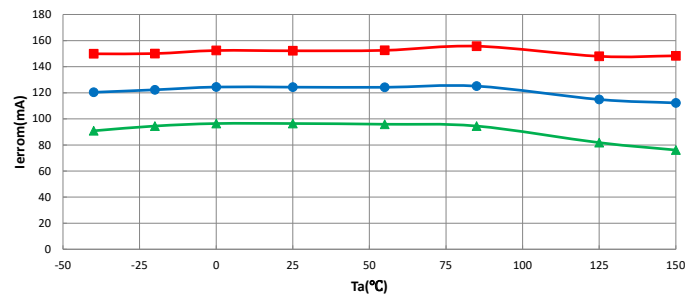
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

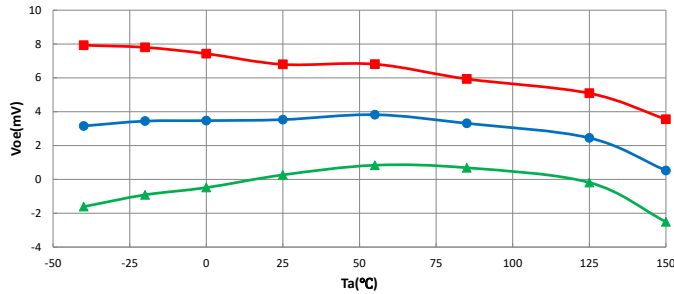


—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

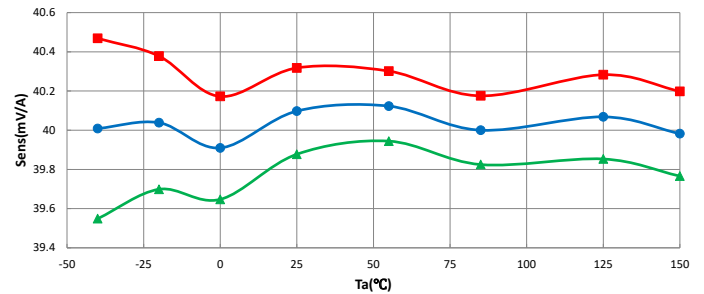
CHARACTERISTIC PERFORMANCE DATA

ACS772LCB-100U-PFF-T

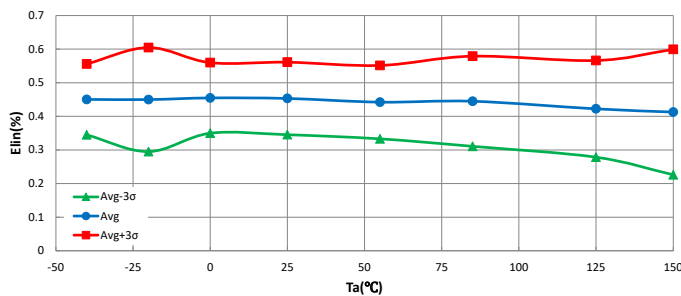
Electrical Offset Voltage versus Ambient Temperature



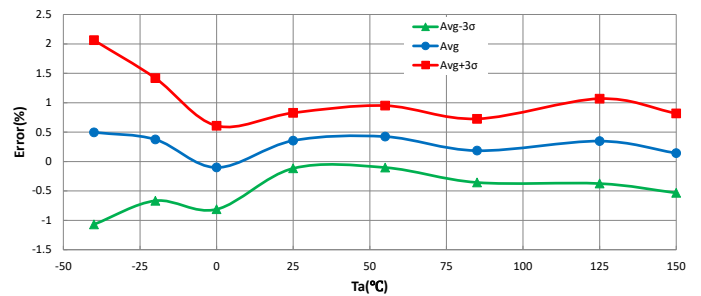
Sensitivity versus Ambient Temperature



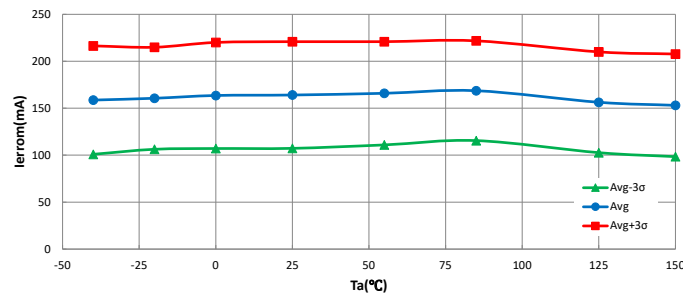
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature

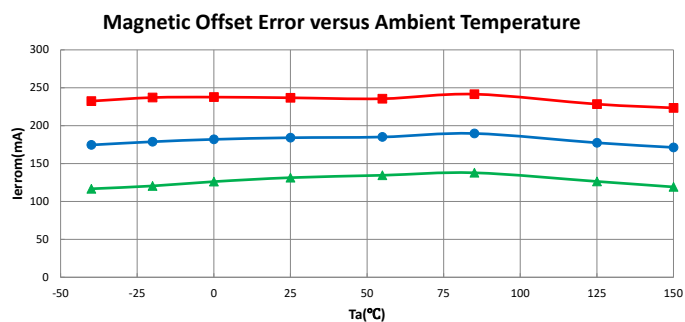
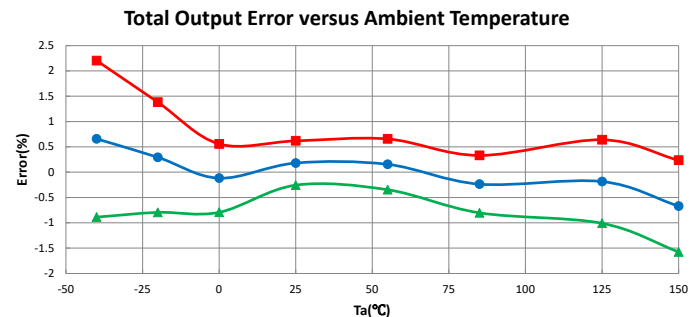
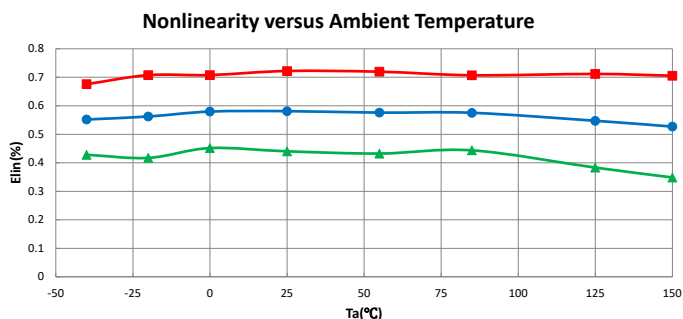
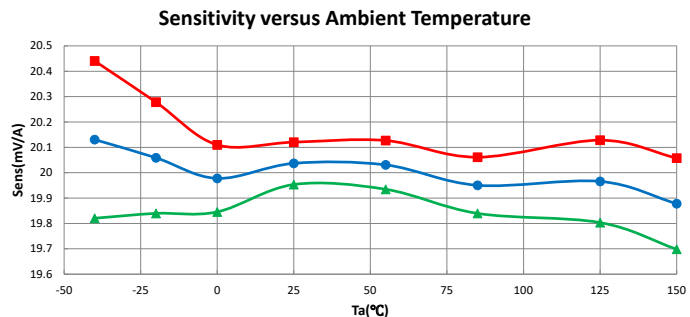
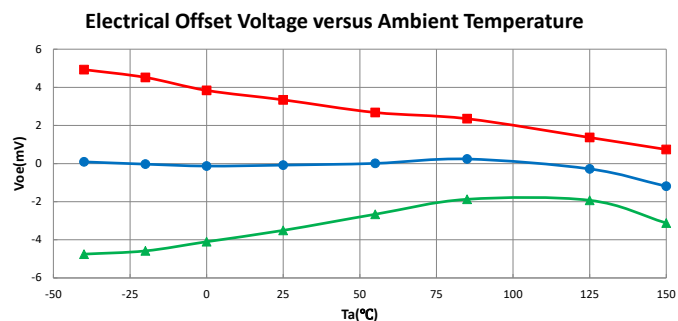


Magnetic Offset Error versus Ambient Temperature



—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

CHARACTERISTIC PERFORMANCE DATA ACS772LCB-100B-PFF-T

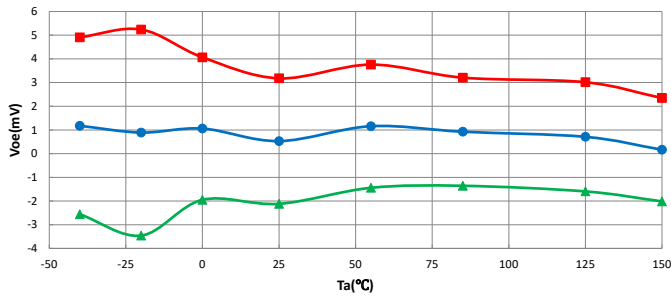


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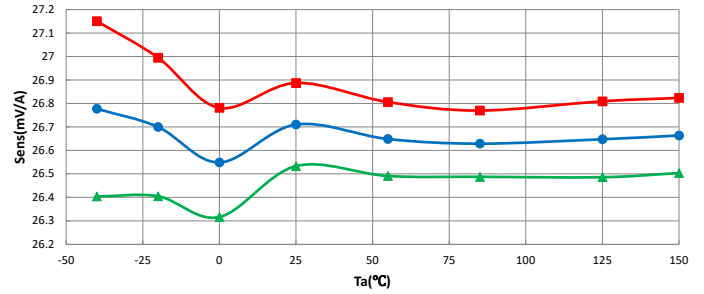
CHARACTERISTIC PERFORMANCE DATA

ACS772KCB-150U-PFF-T

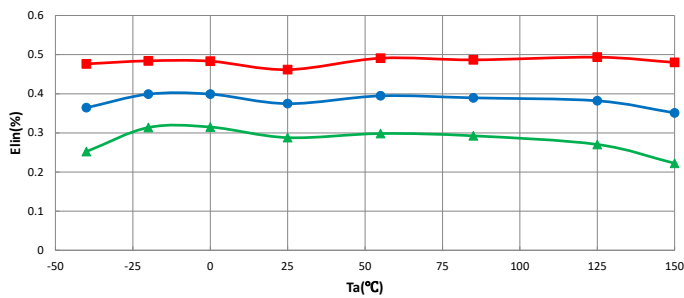
Electrical Offset Voltage versus Ambient Temperature



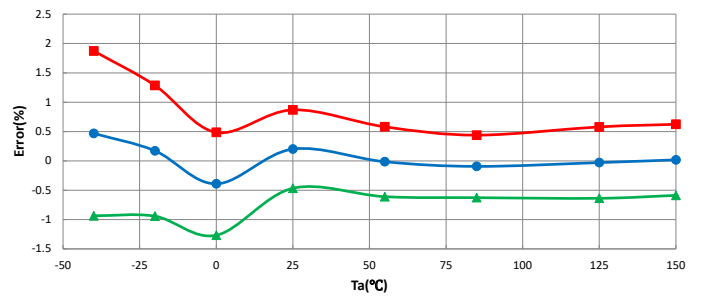
Sensitivity versus Ambient Temperature



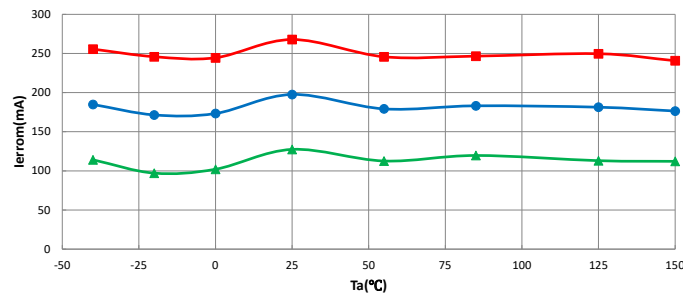
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

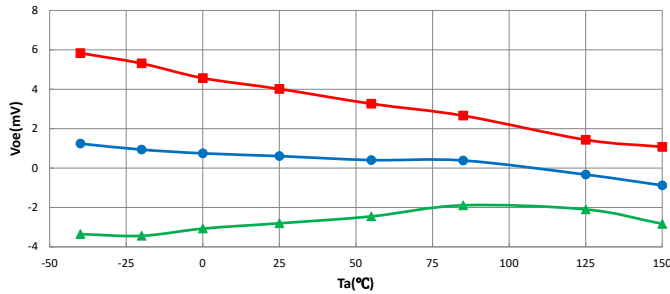


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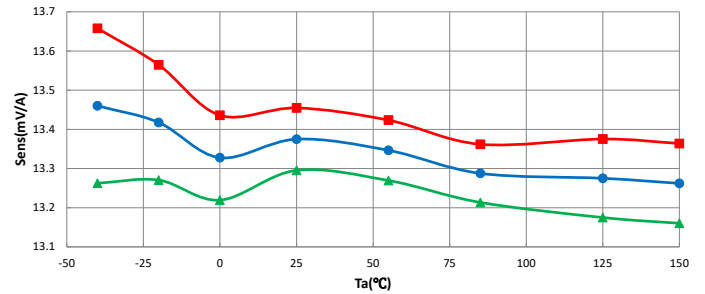
CHARACTERISTIC PERFORMANCE DATA

ACS772KCB-150B-PFF-T

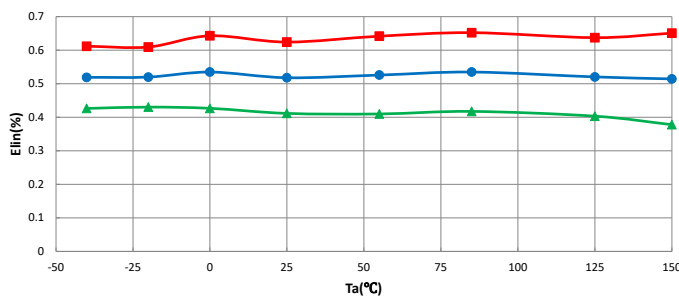
Electrical Offset Voltage versus Ambient Temperature



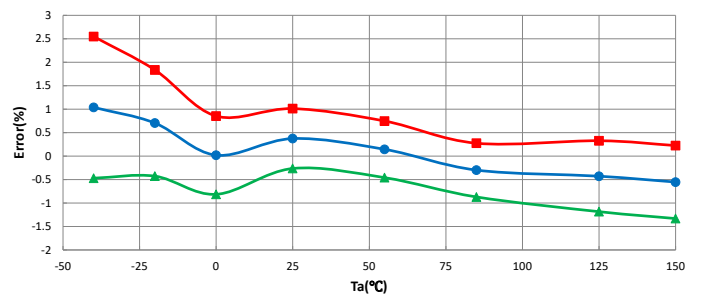
Sensitivity versus Ambient Temperature



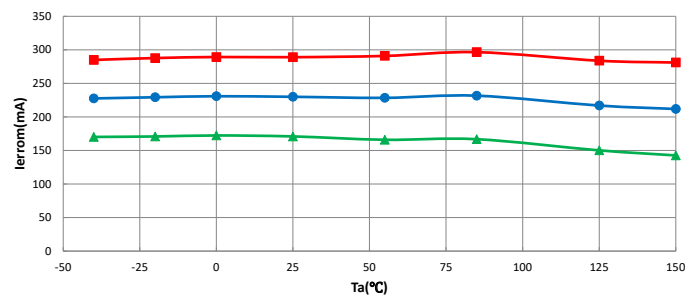
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

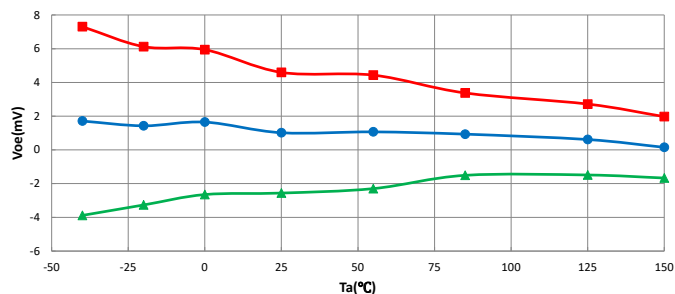


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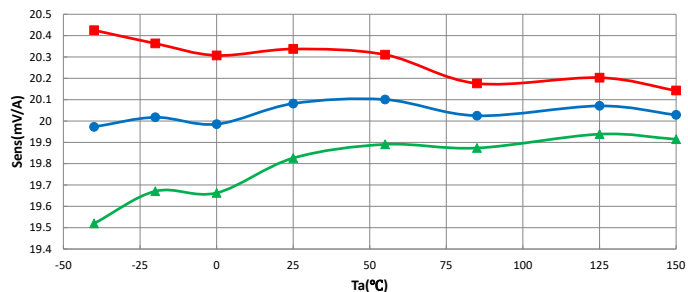
CHARACTERISTIC PERFORMANCE DATA

ACS772ECB-200U-PFF-T

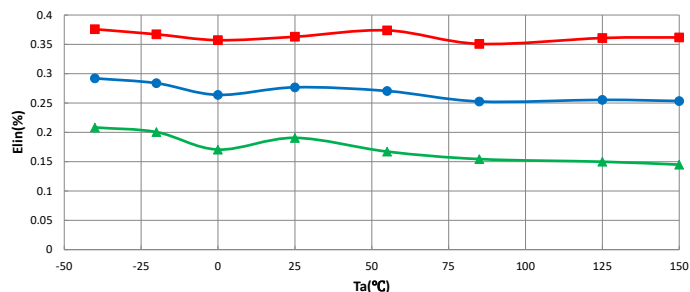
Electrical Offset Voltage versus Ambient Temperature



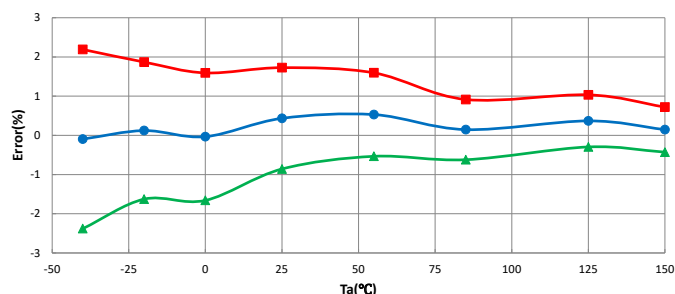
Sensitivity versus Ambient Temperature



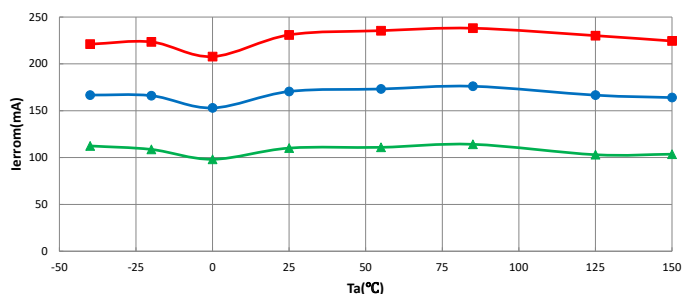
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

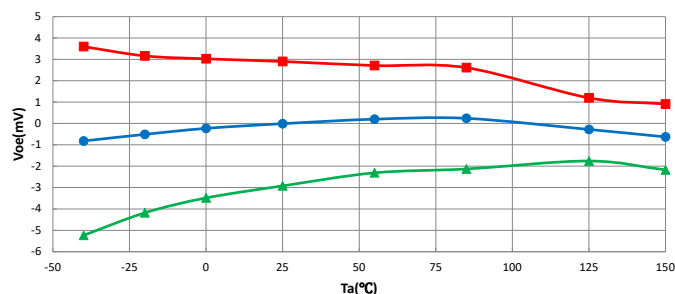


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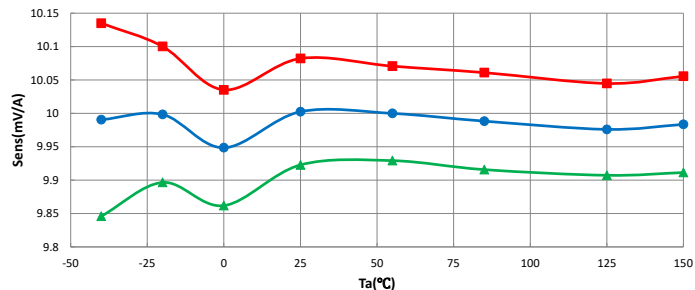
CHARACTERISTIC PERFORMANCE DATA

ACS772ECB-200B-PFF-T

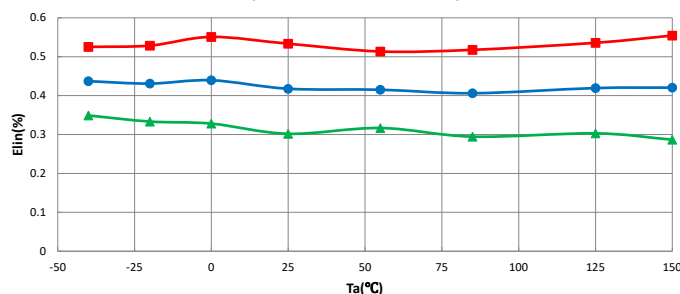
Electrical Offset Voltage versus Ambient Temperature



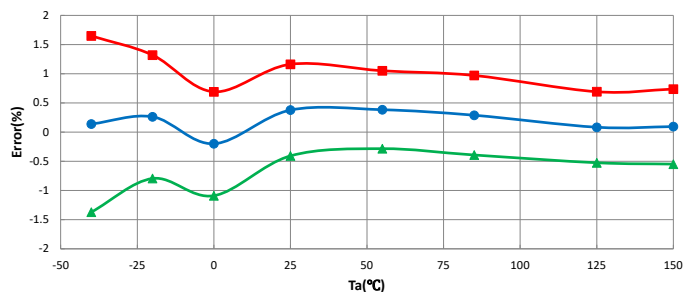
Sensitivity versus Ambient Temperature



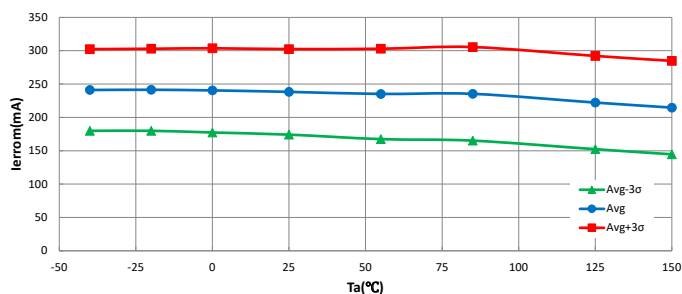
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

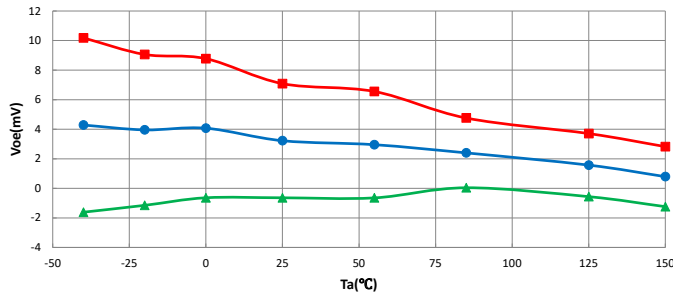


—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

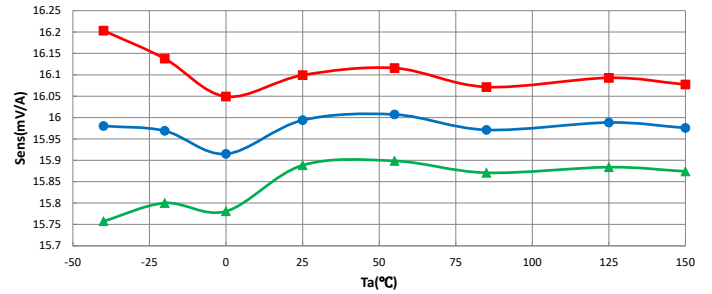
CHARACTERISTIC PERFORMANCE DATA

ACS772ECB-250U-PFF-T

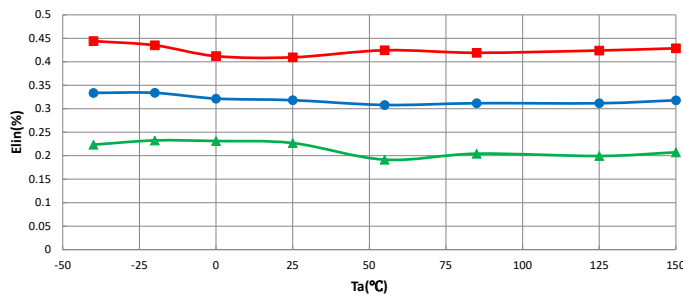
Electrical Offset Voltage versus Ambient Temperature



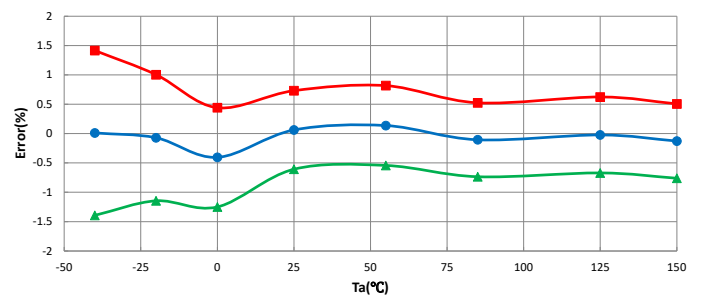
Sensitivity versus Ambient Temperature



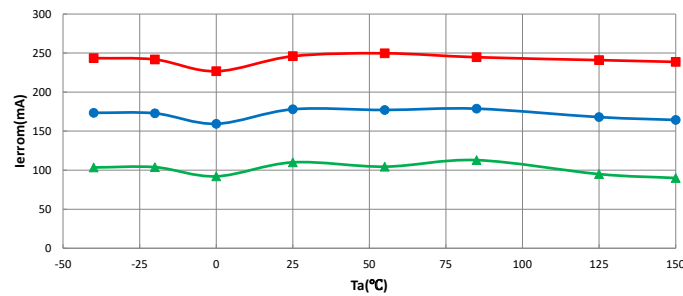
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

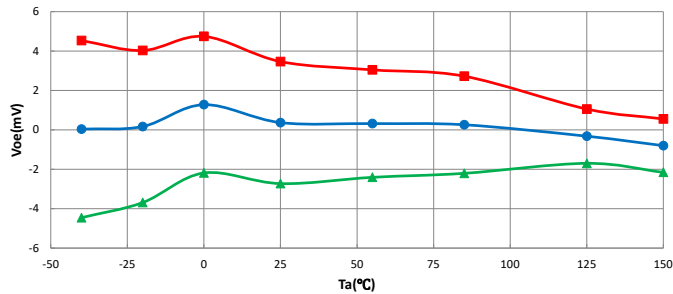


—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

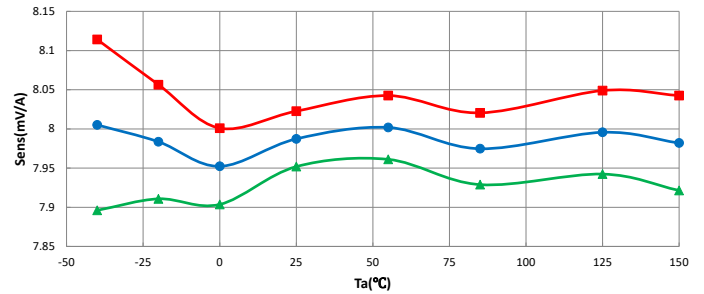
CHARACTERISTIC PERFORMANCE DATA

ACS772ECB-250B-PFF-T

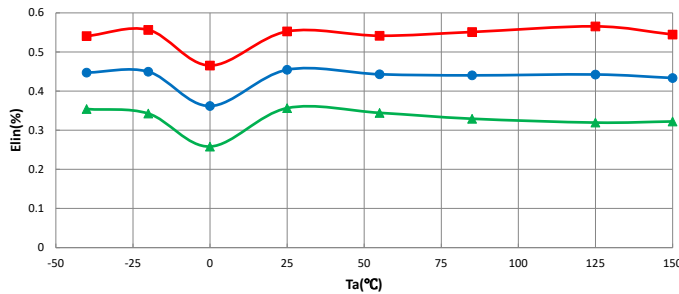
Electrical Offset Voltage versus Ambient Temperature



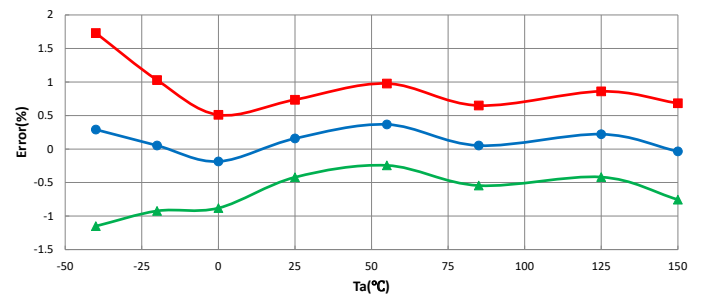
Sensitivity versus Ambient Temperature



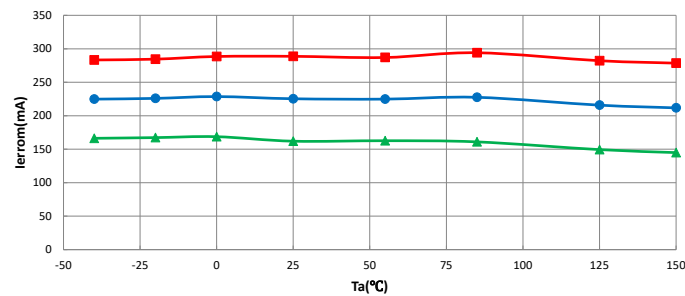
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature

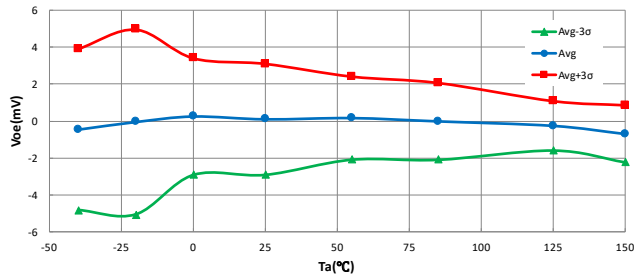


—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

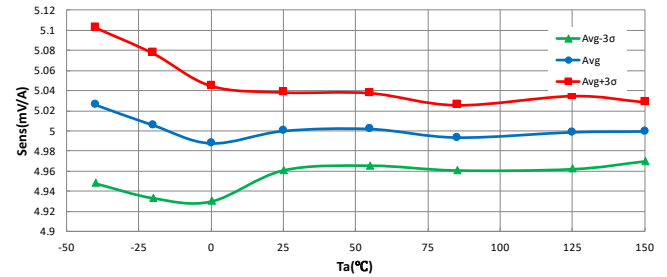
CHARACTERISTIC PERFORMANCE DATA

ACS772ECB-400B-PFF-T

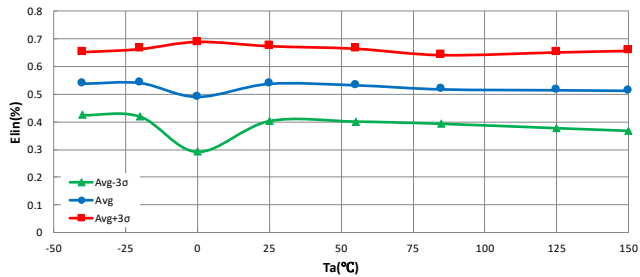
Electrical Offset Voltage versus Ambient Temperature



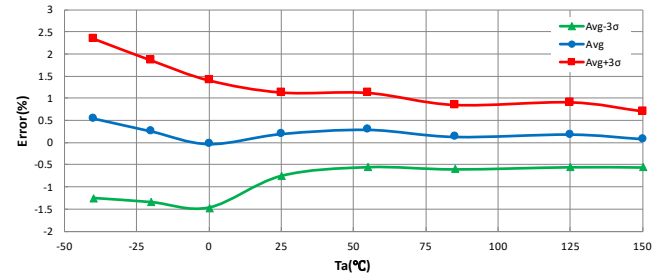
Sensitivity versus Ambient Temperature



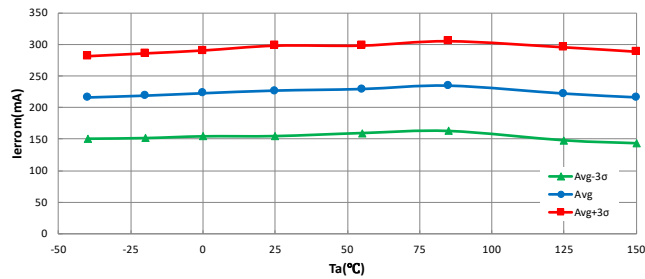
Nonlinearity versus Ambient Temperature



Total Output Error versus Ambient Temperature



Magnetic Offset Error versus Ambient Temperature



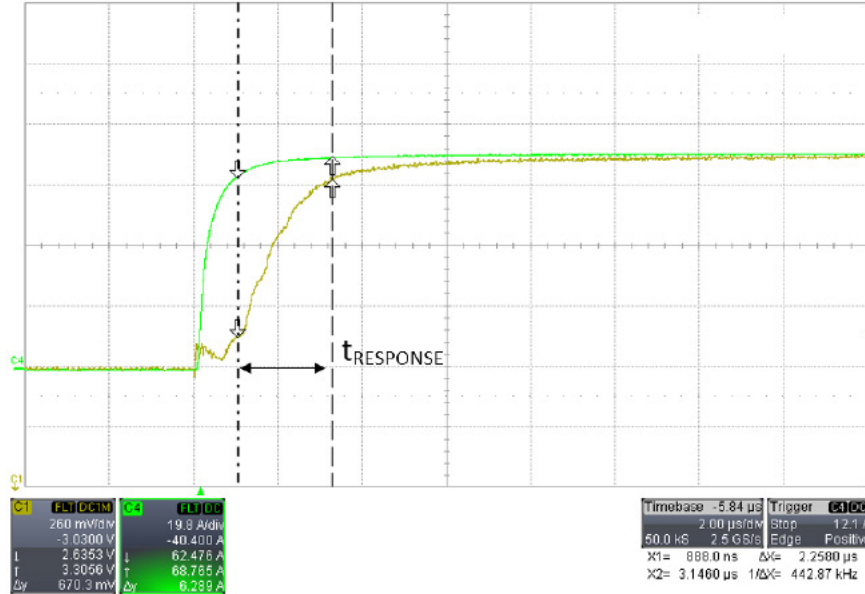
—■— Mean + 3 sigma —●— Mean —▲— Mean - 3 sigma

CHARACTERISTIC PERFORMANCE DATA

Response Time (t_{RESPONSE})

70 A excitation signal with 10%-90% rise time = 1 μs

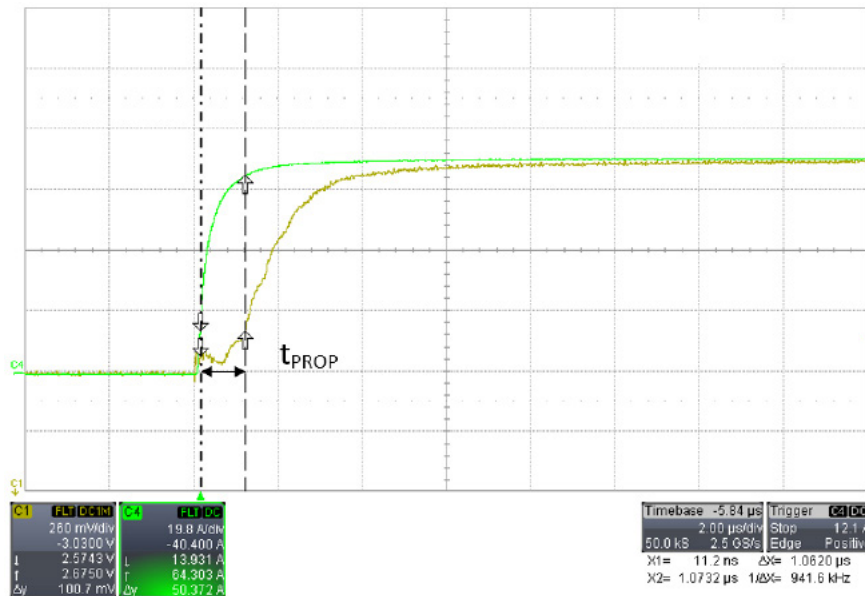
Sensitivity = 13.33 mV/A, $T_A = 25^\circ\text{C}$, $C_{\text{BYPASS}} = 0.1 \mu\text{F}$, $C_{\text{LOAD}} = 1 \text{ nF}$



Propagation Delay (t_{PROP})

70 A excitation signal with 10%-90% rise time = 1 μs

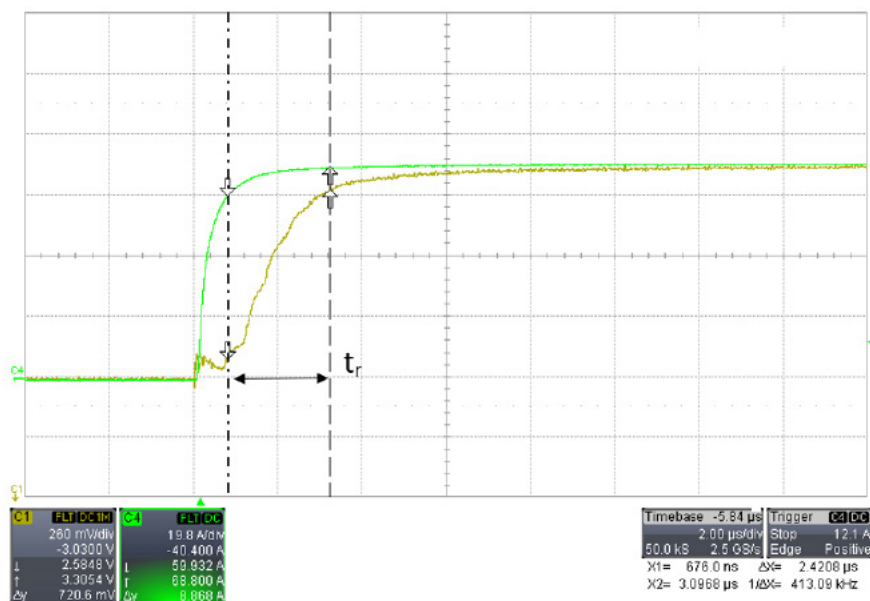
Sensitivity = 13.33 mV/A, $T_A = 25^\circ\text{C}$, $C_{\text{BYPASS}} = 0.1 \mu\text{F}$, $C_{\text{LOAD}} = 1 \text{ nF}$



Rise Time (t_R)

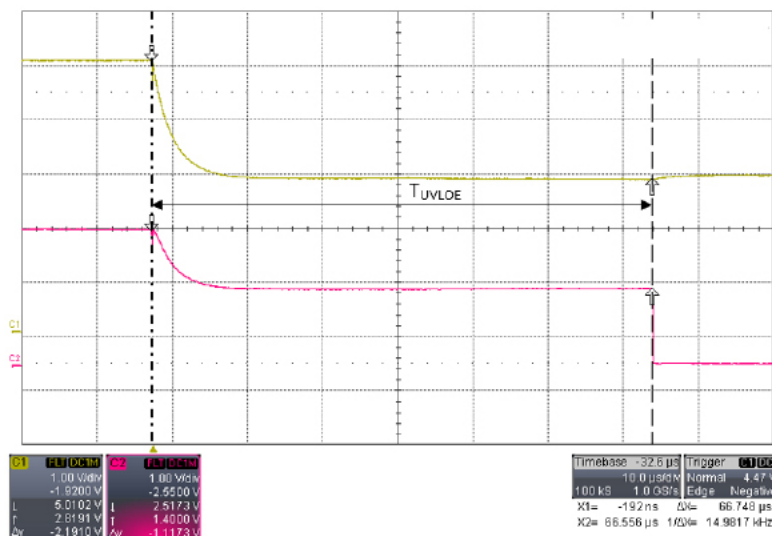
70 A excitation signal with 10%-90% rise time = 1 μs

Sensitivity = 13.33 mV/A, $T_A = 25^\circ\text{C}$, $C_{\text{BYPASS}} = 0.1 \mu\text{F}$, $C_{\text{LOAD}} = 1 \text{ nF}$



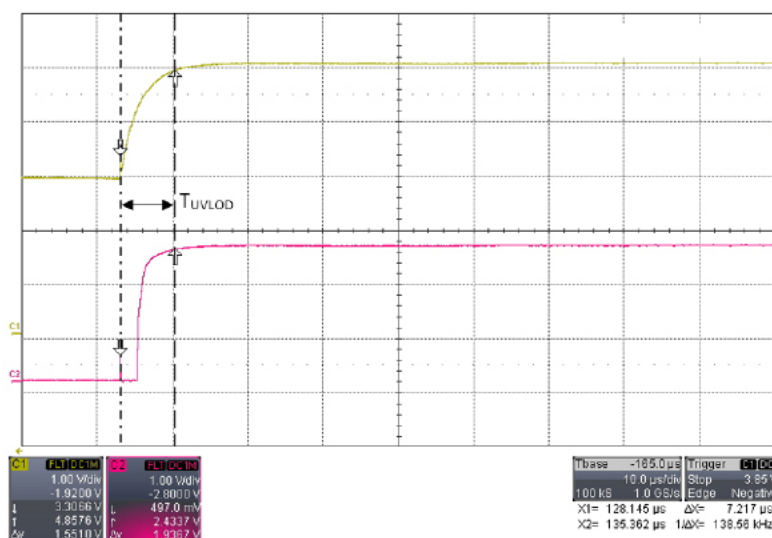
UVLO Enable Time (t_{UVLOE})

V_{CC} 5 V to 3 V fall time = 1.5 μ s, C_L = 1 nF



UVLO Disble Time (t_{UVLOD})

V_{CC} 3 V to 5 V recovery time = 1.5 μ s, C_L = 1 nF



CHARACTERISTIC DEFINITIONS

Definitions of Accuracy Characteristics

SENSITIVITY (S_{ens})

The change in sensor IC output in response to a 1 A change through the primary conductor. The sensitivity is the product of the magnetic circuit sensitivity (G/A; 1 G = 0.1 mT) and the linear IC amplifier gain (mV/G). The linear IC amplifier gain is programmed at the factory to optimize the sensitivity (mV/A) for the full-scale current of the device.

SENSITIVITY ERROR (E_{Sens})

The sensitivity error is the percent difference between the measured sensitivity and the ideal sensitivity. For example, in the case of $V_{\text{CC}} = 5 \text{ V}$:

$$E_{\text{Sens}} = \frac{S_{\text{ensMeas}}(5\text{V}) - S_{\text{ensIdeal}}(5\text{V})}{S_{\text{ensIDEAL}}(5\text{V})} \times 100 (\%)$$

NOISE (V_{N})

The noise floor is derived from the thermal and shot noise observed in Hall elements. Dividing the noise (mV) by the sensitivity (mV/A) provides the smallest current that the device is able to resolve.

NONLINEARITY (E_{LIN})

The ACS772 is designed to provide a linear output in response to a ramping current. Consider two current levels: I1 and I2. Ideally, the sensitivity of a device is the same for both currents, for a given supply voltage and temperature. Nonlinearity is present when there is a difference between the sensitivities measured at I1 and I2. Nonlinearity is calculated separately for the positive (E_{LINpos}) and negative (E_{LINneg}) applied currents as follows:

$$E_{\text{LINpos}} = 100 (\%) \times \{1 - (S_{\text{ensIPOS2}} / S_{\text{ensIPOS1}})\}$$

$$E_{\text{LINneg}} = 100 (\%) \times \{1 - (S_{\text{ensINEG2}} / S_{\text{ensINEG1}})\}$$

where:

$$S_{\text{ensIx}} = (V_{\text{IOUT(Ix)}} - V_{\text{IOUT(Q)}}) / I_x$$

and I_{POSx} and I_{NEGx} are positive and negative currents and $I_{\text{POS2}} = 2 \times I_{\text{POS1}}$ and $I_{\text{NEG2}} = 2 \times I_{\text{NEG1}}$.

Then:

$$E_{\text{LIN}} = \max(E_{\text{LINpos}}, E_{\text{LINneg}})$$

SYMMETRY (E_{SYM})

The degree to which the absolute voltage output from the IC var-

ies in proportion to either a positive or negative half-scale primary current. The following equation is used to derive symmetry:

$$100 \times \left(\frac{V_{\text{IOUT}_{+}\text{half-scale amperes}} - V_{\text{IOUT(Q)}}}{V_{\text{IOUT(Q)}} - V_{\text{IOUT}_{-}\text{half-scale amperes}}} \right)$$

RATIOMETRY ERROR

The device features a ratiometric output. This means that the quiescent voltage output, V_{IOUTQ} , and the magnetic sensitivity, S_{ens} , are proportional to the supply voltage, V_{CC} . The ratiometric change (%) in the quiescent voltage output is defined as:

$$\text{Rat}_{\text{ErrQVO}} = \left[1 - \frac{(V_{\text{IOUTQ}(V_{\text{CC}})} / V_{\text{IOUTQ}(5\text{V})})}{V_{\text{CC}} / 5 \text{ V}} \right] \times 100\%$$

and the ratiometric change (%) in sensitivity is defined as:

$$\text{Rat}_{\text{ErrSens}} = \left[1 - \frac{(S_{\text{ens}(V_{\text{CC}})} / S_{\text{ense}(5\text{V})})}{V_{\text{CC}} / 5 \text{ V}} \right] \times 100\%$$

ZERO CURRENT OUTPUT VOLTAGE ($V_{\text{IOUT(Q)}}$)

The output of the sensor when the primary current is zero. It nominally remains at $0.5 \times V_{\text{CC}}$ for a bidirectional device and $0.1 \times V_{\text{CC}}$ for a unidirectional device. For example, in the case of a bidirectional output device, $V_{\text{CC}} = 5 \text{ V}$ translates into $V_{\text{IOUT(Q)}} = 2.5 \text{ V}$. Variation in $V_{\text{IOUT(Q)}}$ can be attributed to the resolution of the Allegro linear IC quiescent voltage trim and thermal drift.

ELECTRICAL OFFSET VOLTAGE (V_{OE})

The deviation of the device output from its ideal quiescent value of $0.5 \times V_{\text{CC}}$ (bidirectional) or $0.1 \times V_{\text{CC}}$ (unidirectional) due to nonmagnetic causes. To convert this voltage to amperes, divide by the device sensitivity, S_{ens} .

MAGNETIC OFFSET ERROR (I_{ERROM})

The magnetic offset is due to the residual magnetism (remnant field) of the core material. The magnetic offset error is highest when the magnetic circuit has been saturated, usually when the device has been subjected to a full-scale or high-current overload condition. The magnetic offset is largely dependent on the material used as a flux concentrator. The larger magnetic offsets are observed at the lower operating temperatures.

TOTAL OUTPUT ERROR (E_{TOT})

The difference between the current measurement from the sensor IC and the actual current (I_P), relative to the actual current. This is equivalent to the difference between the ideal output voltage and the actual output voltage, divided by the ideal sensitivity, relative to the current flowing through the primary conduction path:

$$E_{TOT}(I_P) = \frac{V_{IOUT}(I_P) - V_{IOUT(ideal)}(I_P)}{Sens_{ideal} \times I_P} \times 100(\%)$$

where

$$V_{IOUT(ideal)}(I_P) = V_{IOUT(Q)} + (Sens_{IDEAL} \times I_P)$$

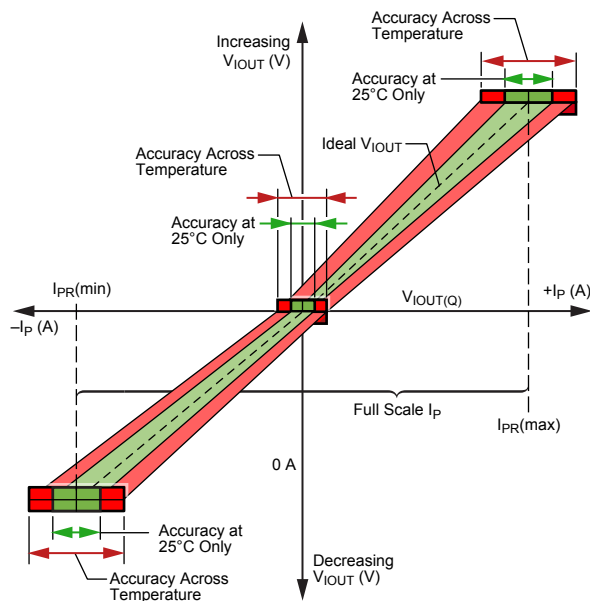


Figure 1: Output Voltage versus Sensed Current

The Total Output Error incorporates all sources of error and is a function of I_P .

At relatively high currents, E_{TOT} will be mostly due to sensitivity error, and at relatively low currents, E_{TOT} will be mostly due to Offset Voltage (V_{OE}). In fact, as I_P approaches zero, E_{TOT} approaches infinity due to the offset voltage. This is illustrated in Figure 1 and Figure 2. Figure 1 shows a distribution of output voltages versus I_P at 25°C and across temperature. Figure 2 shows the corresponding E_{TOT} versus I_P .

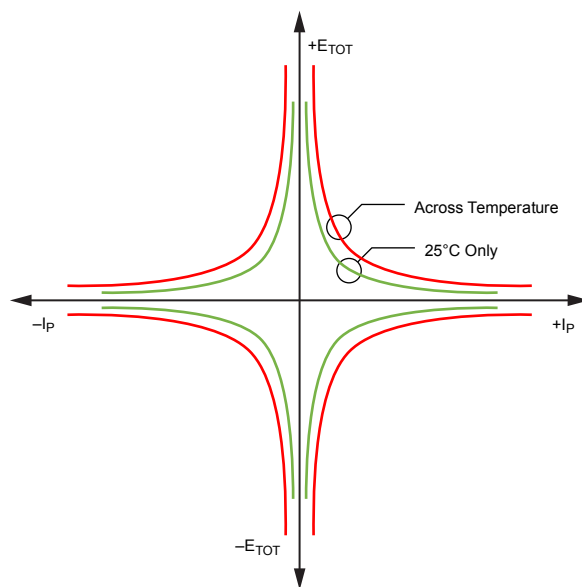


Figure 2: Total Output Error versus Sensed Current

Definitions of Dynamic Response Characteristics

POWER-ON DELAY (t_{POD})

When the supply is ramped to its operating voltage, the device requires a finite time to power its internal components before responding to an input magnetic field. Power-On Delay, t_{POD} , is defined as the time it takes for the output voltage to settle within $\pm 10\%$ of its steady-state value under an applied magnetic field, after the power supply has reached its minimum specified operating voltage, $V_{CC(min)}$, as shown in the chart at right.

RISE TIME (t_r)

The time interval between a) when the sensor reaches 10% of its full-scale value, and b) when it reaches 90% of its full-scale value.

PROPAGATION DELAY (t_{PROP})

The time interval between a) when the sensed current reaches 20% of its full-scale value, and b) when the sensor output reaches 20% of its full-scale value.

RESPONSE TIME ($t_{RESPONSE}$)

The time interval between a) when the applied current reaches 90% of its final value, and b) when the sensor reaches 90% of its output corresponding to the applied current.

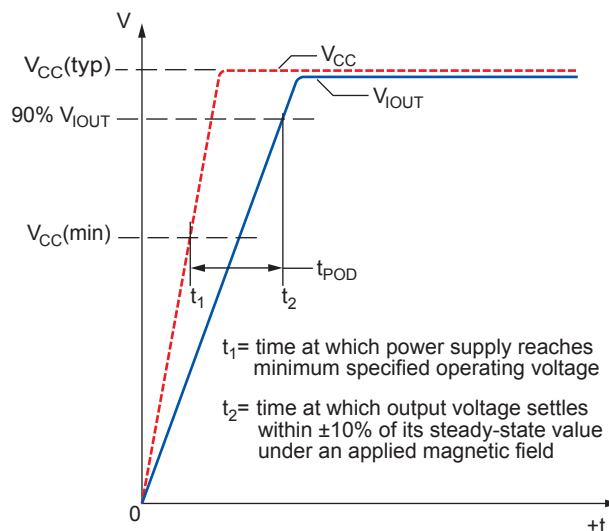


Figure 3: Power-On Delay (t_{POD})

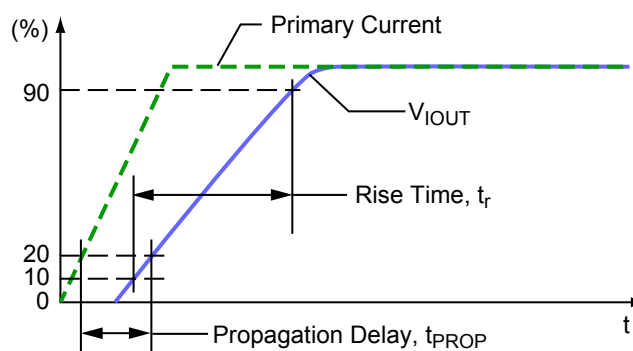


Figure 4: Rise Time (t_r) and Propagation Delay (t_{PROP})

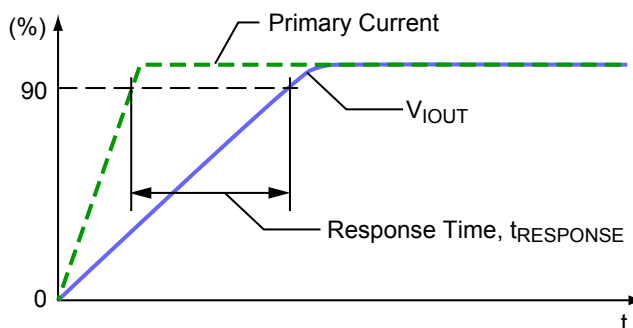


Figure 5: Response Time ($t_{RESPONSE}$)

FUNCTIONAL DESCRIPTION

Power-On Reset (POR) and Undervoltage Lockout (UVLO) Operation

The descriptions in this section assume: temperature = 25°C, no output load (RL, CL), and no significant magnetic field is present.

Power-Up

At power-up, as V_{CC} ramps up, the output is in a high-impedance state. When V_{CC} crosses V_{PORH} (location [1] in Figure 6 and [1'] in Figure 7), the POR Release counter starts counting for t_{PORR} . At this point, if V_{CC} exceeds V_{UVLOH} [2'], the output will go to $V_{CC} / 2$ after t_{UVLOD} [3'].

If V_{CC} does not exceed V_{UVLOH} [2], the output will stay in the high-impedance state until V_{CC} reaches V_{UVLOH} [3] and then will go to $V_{CC} / 2$ after t_{UVLOD} [4].

V_{CC} drops below $V_{CC(min)} = 4.5\text{ V}$

If V_{CC} drops below V_{UVLOL} [4', 5], the UVLO Enable Counter starts counting. If V_{CC} is still below V_{UVLOL} when the counter reaches t_{UVLOE} , the UVLO function will be enabled and the

output will be pulled near GND [6]. If V_{CC} exceeds V_{UVLOL} before the UVLO Enable Counter reaches t_{UVLOE} [5'], the output will continue to be $V_{CC} / 2$.

Coming Out of UVLO

While UVLO is enabled [6], if V_{CC} exceeds V_{UVLOH} [7], UVLO will be disabled after t_{UVLOD} , and the output will be $V_{CC} / 2$ [8].

Power-Down

As V_{CC} ramps down below V_{UVLOL} [6', 9], the UVLO Enable Counter will start counting. If V_{CC} is higher than V_{PORL} when the counter reaches t_{UVLOE} , the UVLO function will be enabled and the output will be pulled near GND [10]. The output will enter a high-impedance state as V_{CC} goes below V_{PORL} [11]. If V_{CC} falls below V_{PORL} before the UVLO Enable Counter reaches t_{UVLOE} , the output will transition directly into a high-impedance state [7'].

EEPROM Error Checking And Correction

Hamming code methodology is implemented for EEPROM checking and correction. The device has ECC enabled after power-up. If an uncorrectable error has occurred, the VOUT pin will go to high impedance and the device will not respond to applied magnetic field.

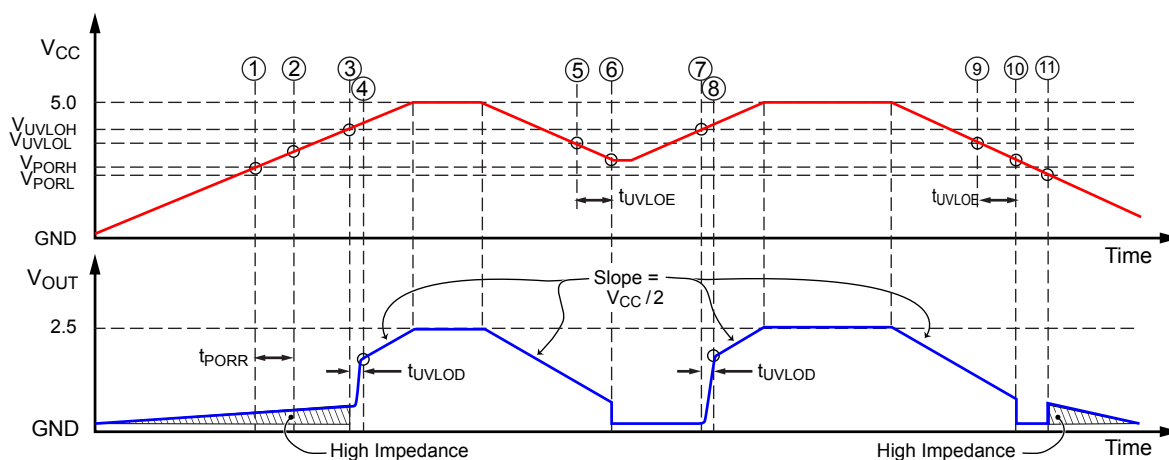


Figure 6: POR and UVLO Operation: Slow Rise Time Case

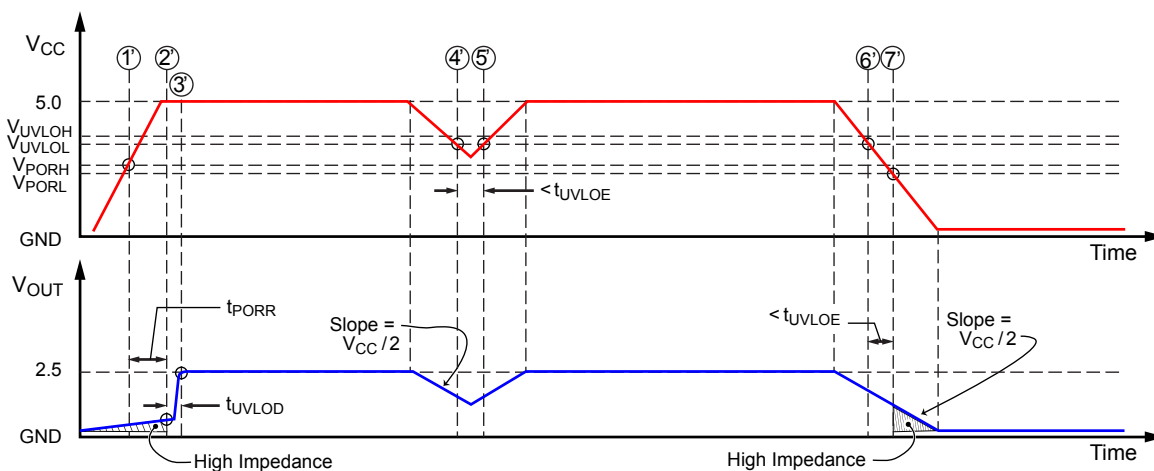


Figure 7: POR and UVLO Operation: Fast Rise Time Case

Chopper Stabilization Technique

When using Hall-effect technology, a limiting factor for switchpoint accuracy is the small signal voltage developed across the Hall element. This voltage is disproportionately small relative to the offset that can be produced at the output of the Hall sensor IC. This makes it difficult to process the signal while maintaining an accurate, reliable output over the specified operating temperature and voltage ranges.

Chopper stabilization is a unique approach used to minimize Hall offset on the chip. Allegro employs a technique to remove key sources of the output drift induced by thermal and mechanical stresses. This offset reduction technique is based on a signal modulation-demodulation process. The undesired offset signal is separated from the magnetic field-induced signal in the frequency domain, through modulation. The subsequent demodulation acts as a modulation process for the offset, causing the magnetic field-induced signal to recover its original spectrum at baseband, while the DC offset becomes a high-frequency signal. The magnetic-

sourced signal then can pass through a low-pass filter, while the modulated DC offset is suppressed.

In addition to the removal of the thermal and stress related offset, this novel technique also reduces the amount of thermal noise in the Hall sensor IC while completely removing the modulated residue resulting from the chopper operation. The chopper stabilization technique uses a high-frequency sampling clock. For demodulation process, a sample-and-hold technique is used. This high-frequency operation allows a greater sampling rate, which results in higher accuracy and faster signal-processing capability. This approach desensitizes the chip to the effects of thermal and mechanical stresses, and produces devices that have extremely stable quiescent Hall output voltages and precise recoverability after temperature cycling. This technique is made possible through the use of a BiCMOS process, which allows the use of low-offset, low-noise amplifiers in combination with high-density logic integration and sample-and-hold circuits.

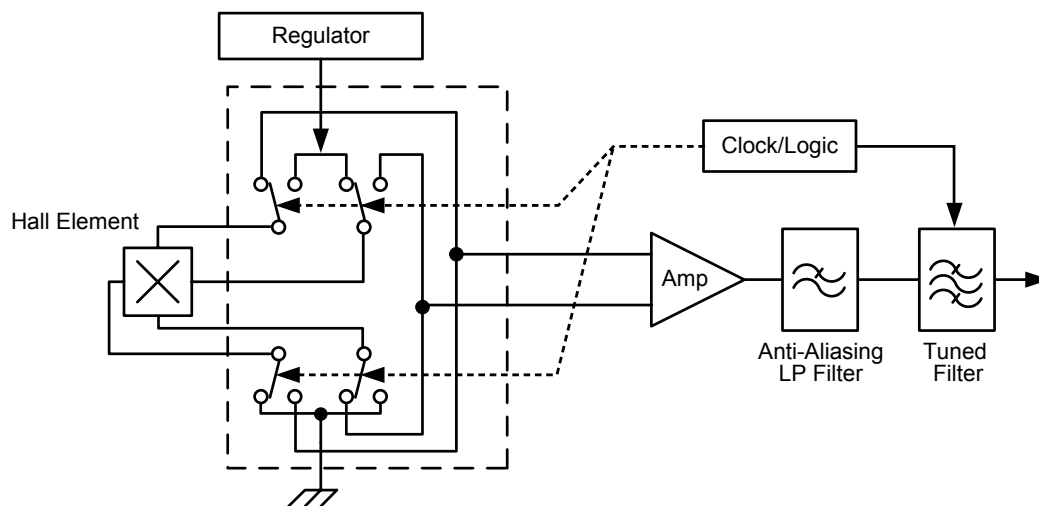


Figure 8: Concept of Chopper Stabilization Technique

APPLICATION INFORMATION

Thermal Rise vs. Primary Current

Self-heating due to the flow of current should be considered during the design of any current sensing system. The sensor, printed circuit board (PCB), and contacts to the PCB will generate heat as current moves through the system.

The thermal response is highly dependent on PCB layout, copper thickness, cooling techniques, and the profile of the injected current. The current profile includes peak current, current “on-time”, and duty cycle. While the data presented in this section was collected with direct current (DC), these numbers may be used to approximate thermal response for both AC signals and current pulses.

The plot in Figure 9 shows the measured rise in steady-state die temperature of the ACS772 versus continuous current at an ambient temperature, T_A , of 25°C. The thermal offset curves may be directly applied to other values of T_A . Conversely, Figure 10 shows the maximum continuous current at a given T_A . Surges beyond the maximum current listed in Figure 10 are allowed given the maximum junction temperature, $T_{J(MAX)}$ (165°C), is not exceeded.

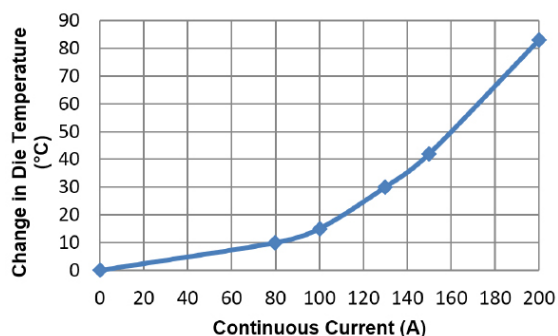


Figure 9: Self-Heating in the CB Package Due to Current Flow

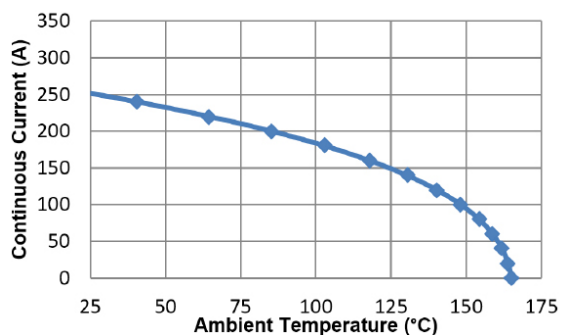


Figure 10: Maximum Continuous Current at a Given T_A

The thermal capacity of the ACS772 should be verified by the end user in the application’s specific conditions. The maximum junction temperature, $T_{J(MAX)}$ (165°C), should not be exceeded. Further information on this application testing is available in the [DC and Transient Current Capability application note](#) on the Allegro website.

ASEK772 Evaluation Board Layout

Thermal data shown in Figure 9 was collected using the ASEK772 Evaluation Board (TED-85-0385-001). This board includes 2664 mm² of 4 oz. copper (0.1388 mm) connected to pins 4 and 5 with thermal vias connecting the layers. Top and bottom layers of the PCB are shown below in Figure 11.

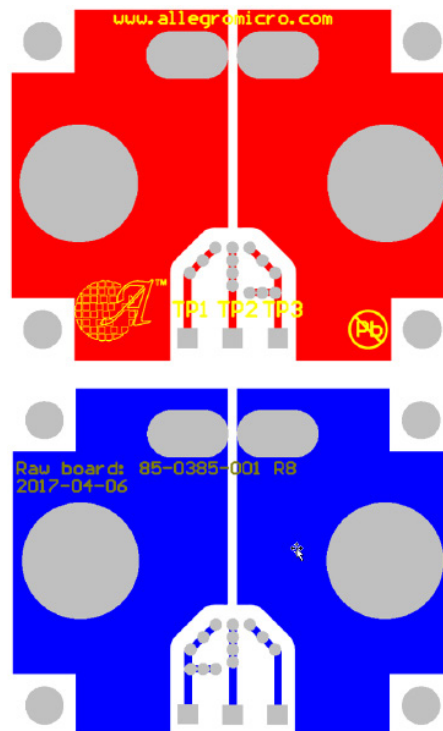


Figure 11: Top and Bottom Layers for ASEK772 Evaluation Board

Gerber files for the ASEK772 evaluation board are available for download from the Allegro website. See the technical documents section of the [ACS772 device webpage](#).

PACKAGE OUTLINE DRAWING

For Reference Only – Not for Tooling Use

(Reference DWG-9111 & DWG-9110)
Dimensions in millimeters – NOT TO SCALE
Dimensions exclusive of mold flash, gate burs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

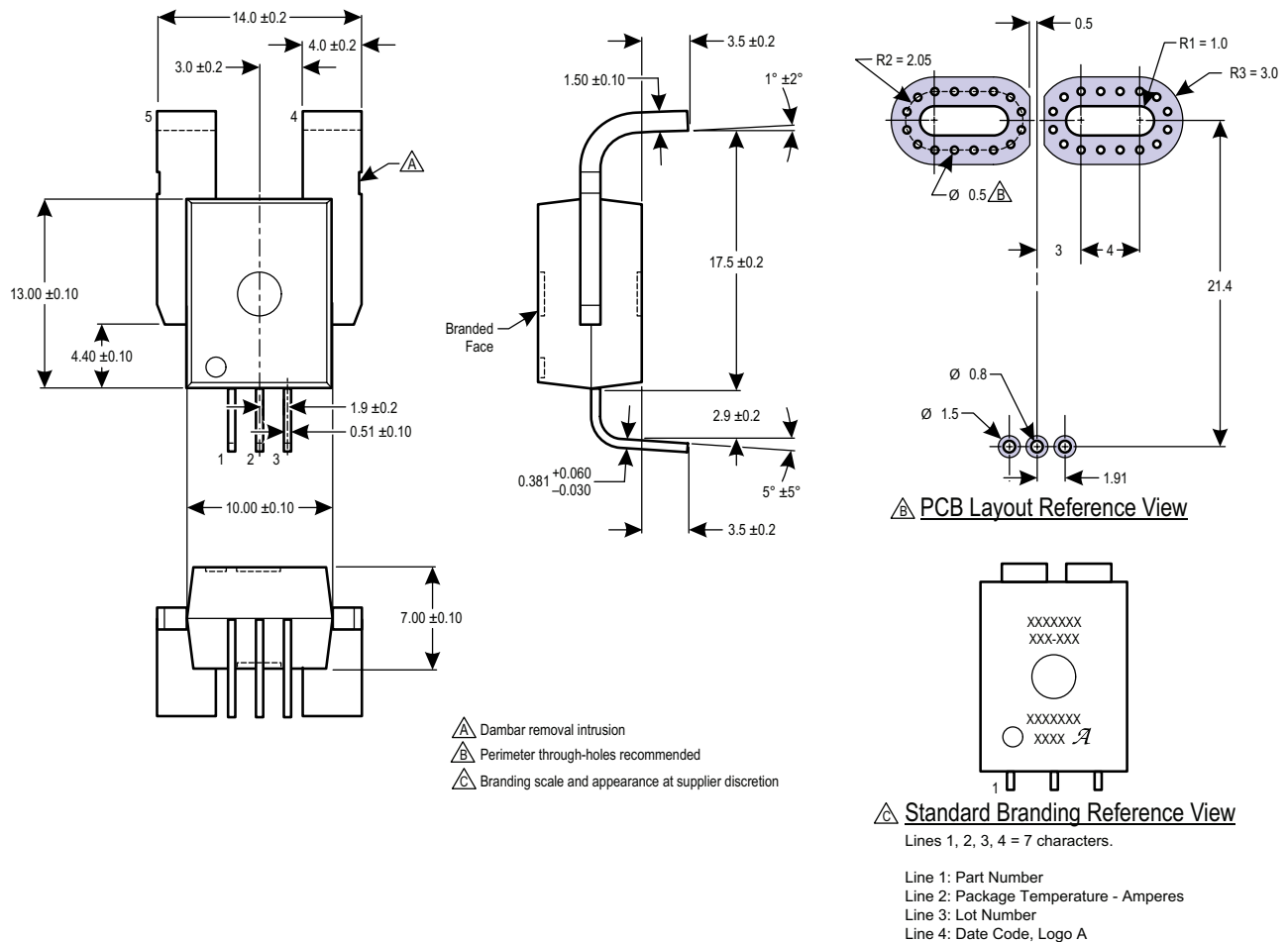


Figure 12: Package CB, 5-Pin, Leadform PFF

For Reference Only – Not for Tooling Use

(Reference DWG-9111, DWG-9110)
Dimensions in millimeters – NOT TO SCALE
Dimensions exclusive of mold flash, gate burs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

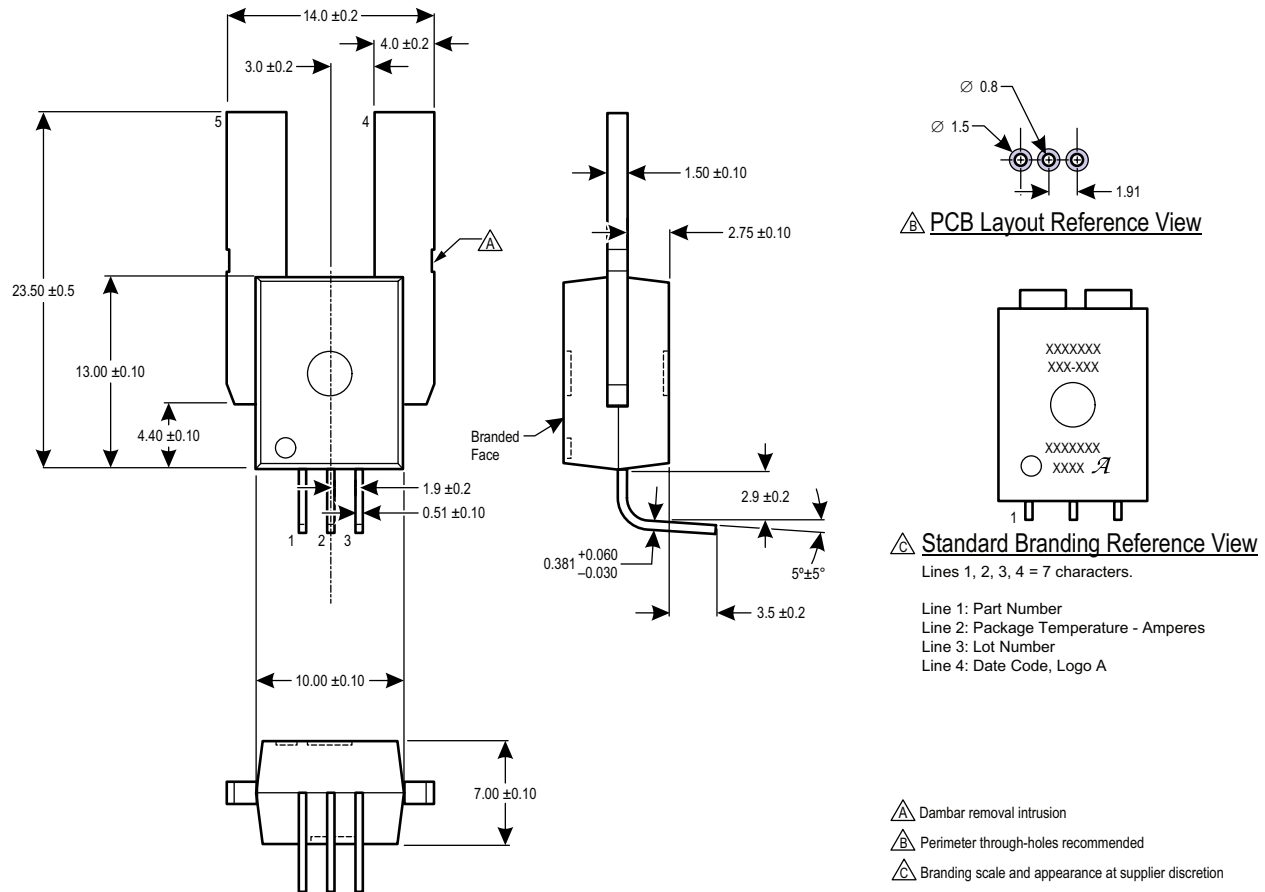


Figure 13: Package CB, 5-Pin, Leadform PSF

For Reference Only – Not for Tooling Use

(Reference DWG-9111, DWG-9110)
Dimensions in millimeters – NOT TO SCALE
Dimensions exclusive of mold flash, gate burs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

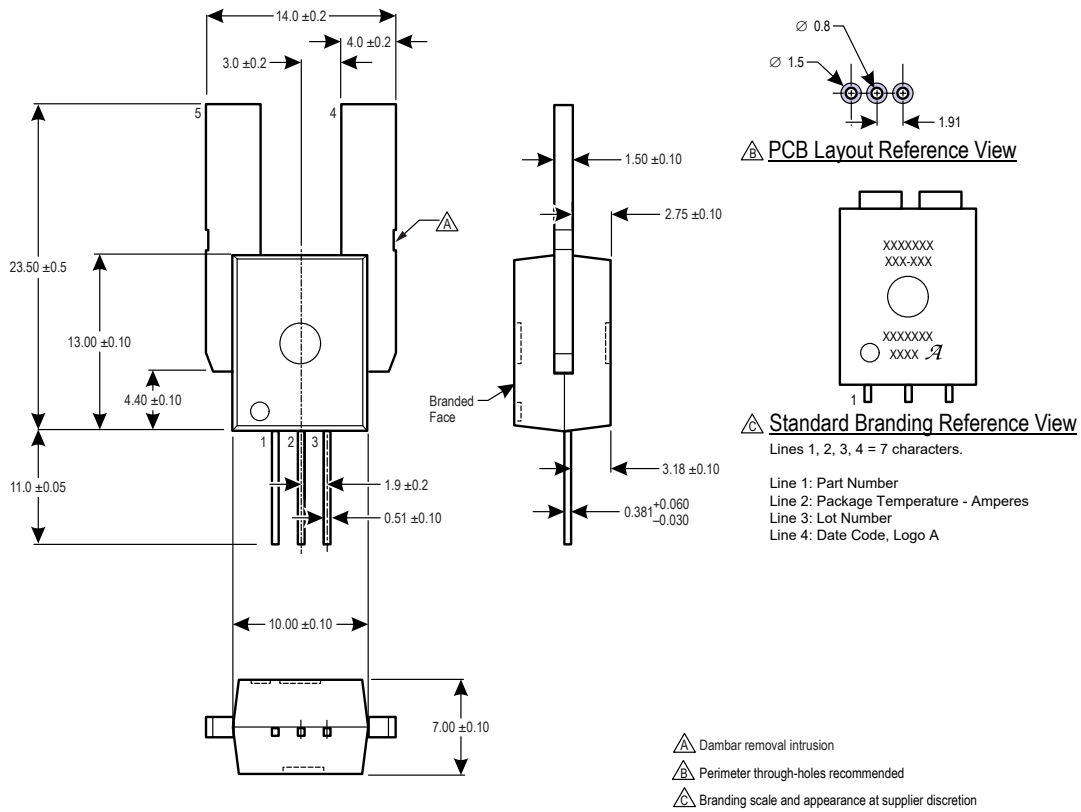


Figure 14: Package CB, 5-Pin, Leadform PSS

For Reference Only – Not for Tooling Use

(Reference DWG-9111, DWG-9110)
Dimensions in millimeters – NOT TO SCALE
Dimensions exclusive of mold flash, gate burs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown

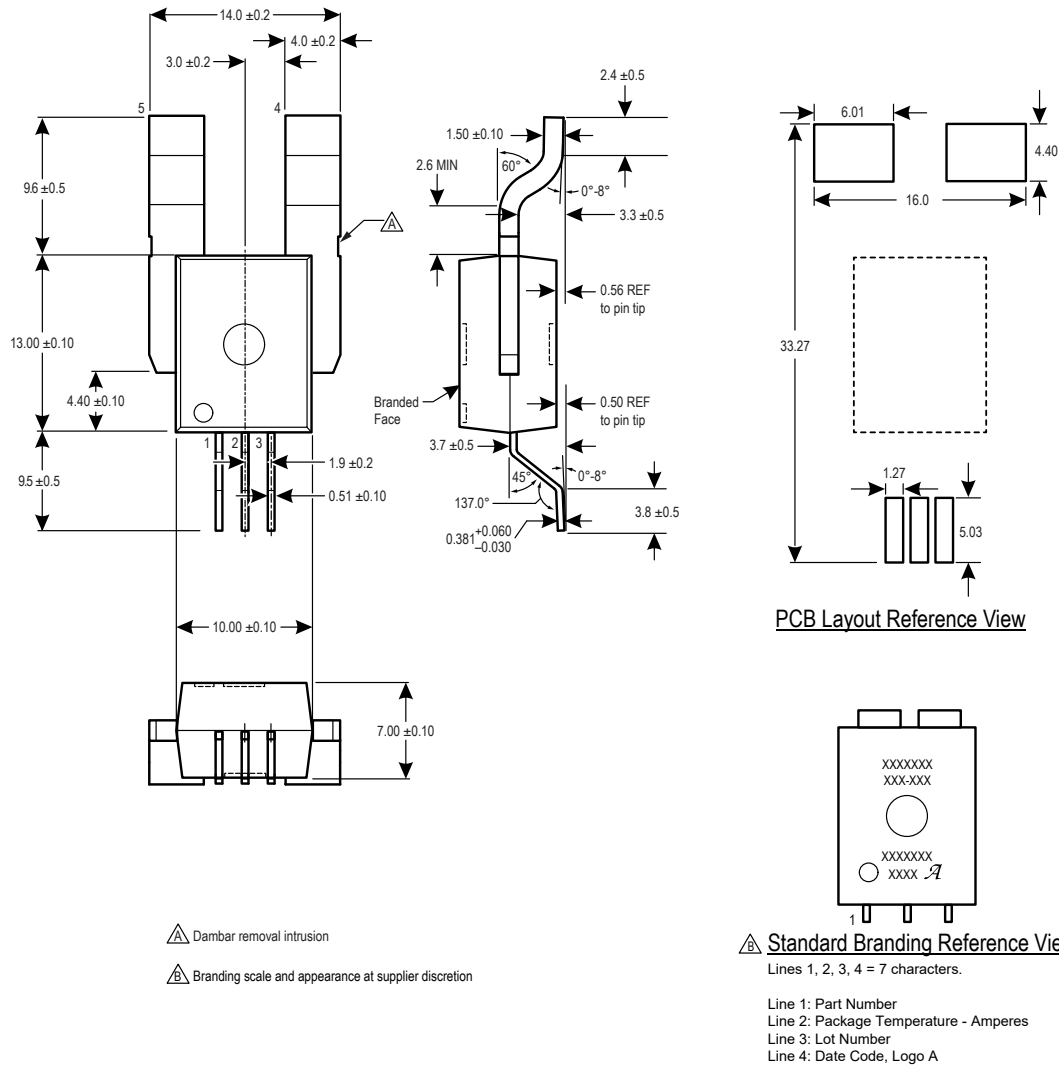


Figure 15: Package CB, 5-Pin, Leadform SMT

Note: The SMT leadform package variant is considered Advance Information, and is subject to change without notice.

Revision History

Number	Date	Description
–	December 12, 2017	Initial release
1	January 30, 2018	Added Dielectric Surge Strength Test Voltage characteristic (page 3) and EEPROM Error Checking and Correction section (page 16)
2	May 14, 2018	Added -050U, -100B, -150U, -200U, -250U, and -250B part options
3	September 24, 2018	Added -PSF leadform option; updated Magnetic Offset Error value (page 13) and Characteristic Performance Data charts (pages 26 to 28)
4	November 12, 2018	Added -300B part option (page 2 and 16); added -PSS leadform option (pages 1, 2, and 39) and Applications Information section (page 36); updated Typical Application (page 1), pinout diagram (page 4), and T_{OP} to T_A (pages 2 and 5-15).
5	December 13, 2018	Added UL certificate; updated package outline drawing PCB layouts and branding (pages 37-39)
6	January 7, 2019	Corrected Sensitivity Error values for -200U part option (page 12)
7	January 24, 2019	Added -400B part option (page 2 and 17)
8	March 14, 2019	Updated package branding (pages 38-40) and Temperature ratings (pages 2-3, 6-17)
9	June 27, 2019	Corrected EVB copper thickness (page 37)
10	August 1, 2019	Added -400B Characteristic Performance Data charts (page 28)
11	August 28, 2019	Added Maximum Continuous Current to Absolute Maximum Ratings table (page 3), ESD ratings table (page 3), and updated thermal data section (page 38)
12	November 6, 2019	Added SMT leadform package variant (pages 1, 3, 43) and Isolation Characteristics Pending Certification (page 4).
13	December 10, 2019	Added PCB Layout Reference View to SMT leadform package drawings (page 43)
14	December 20, 2019	Removed Advance Information status from SMT leadform package variant (pages 1, 3); updated Working Voltage for Basic Isolation and Working Voltage for Reinforced Isolation (page 4), Rise Time, Response Time, Propagation Delay, and Output Slew Rate test conditions, and Output Slew Rate value (page 6).
15	September 30, 2020	Added -150U-SMT and -400U part option (page 3, 17, 19); updated ESD Ratings Test Conditions (page 4); updated Isolation Characteristics table (page 4); corrected Electrical Offset Error (page 13)

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